

HIGH-VOLTAGE MIXED-SIGNAL IC

UG1611s

160COM x 256SEG Matrix LCD Controller-Driver w/ 16-shade per pixel



MP Specifications Revision 1.43

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UC1611s

Single-Chip, Ultra-Low Power 160COM x 256SEG Matrix Passive LCD Controller-Driver

INTRODUCTION

UC1611s is an advanced high-voltage mixed-signal CMOS IC, especially designed for the display needs of ultra-low power hand-held devices.

UC1611s employs UltraChip's unique DCC (Direct Capacitor Coupling) driver architecture and LRM (Line Rate Modulation) gray-shade modulation scheme to achieve near crosstalk free images, with well balanced gray shades.

In addition to low power SEG and COM drivers, UC1611s contains all necessary circuits for high-V LCD power supply, bias voltage generation, timing generation, and graphics data memory.

Advanced circuit design techniques are employed to minimize external component counts and reduce connector size while achieving extremely low power consumption.

MAIN APPLICATIONS

 Cellular Phones, Smart Phones, PDA, and other battery-operated palmtop devices and/or portable instruments.

FEATURE HIGHLIGHTS

- Single-chip controller-driver supports 160x256 STN LCD, 16-shade-per-pixel with gamma compensated modulation.
- Soft-ICON: Partial scroll function to support programmable graphics ICON or scroll bar.
- Support both row ordered and column ordered display buffer RAM access

- Support industry standard 4-wire, 3-wire, and 2-wire serial buses (S8, S9, I²C), and 16- /8- /4-bit parallel buses (8080 or 6800).
- Special driver structure and gray shade modulation scheme produce near crosstalk free image, with low power consumption for all display patterns.
- Fully programmable Mux Rate, partial display window, Bias Ratio, and Line Rate allow many flexible power management options.
- 4 software programmable frame rates (25Hz, 30Hz, 35Hz, and 40Hz). Support the use of fast Liquid Crystal material for speedy LCD response.
- 4 software-programmable temperature compensation coefficients.
- On-chip Power-ON Reset and Software RESET command make RST pin optional.
- Self-configuring 11x charge pump with on-chip pumping capacitor requires only 5 external capacitors to operate.
- Flexible data addressing/mapping schemes to support wide ranges of software models and LCD layout placements.

V_{DD} (digital) range (Typ.): 1.8 V ~ 3.3V
 V_{DD} (analog) range (Typ.): 2.8 V ~ 3.3V
 LCD V_{OP} range: 5.65V ~ 17.5V

Available in gold bump dies

Bump pitch: 38 µM (Typ.)
Bump gap: 13 µM (Typ.)
Bump surface: 1887.5 µM²



ORDERING INFORMATION

High-Voltage Mixed-Signal IC

Product ID	Description
UC1611sGAA	Gold bumped die.

General Notes

APPLICATION INFORMATION

For improved readability, the specification contains many application data points. When application information is given, it is advisory and does not form part of the specification for the device.

BARE DIE DISCLAIMER

All die are tested and are guaranteed to comply with all data sheet limits up to the point of wafer sawing. There is no post waffle saw/pack testing performed on individual die. Although the latest modern processes are utilized for wafer sawing and die pick-&-place into waffle pack carriers. UltraChip has no control of third party procedures in the handling, packing or assembly of the die. Accordingly, it is the responsibility of the customer to test and quality their application in which the die is to be used. UltraChip assumes no liability for device functionality or performance of the die or systems after handling, packing or assembly of the die.

USE OF I2C

The implementation of I²C is already included and tested in all silicon.

MTP LIGHT & ESD SENSITIVITY

The MTP memory cell is sensitive to photon excitation and ESD. Under extended exposure to strong ambient light, or when TST4 pin is exposed to ESD strikes, the MTP cells can lose its content before the specified memory retention time span. The system designer is advised to provide proper light & ESD shields to realize full MTP content retention performance.

LIFE SUPPORT APPLICATIONS

These devices are not designed for use in life support appliances, or systems where malfunction of these products can reasonably be expected to result in personal injuries. Customer using or selling these products for use in such applications do so at their own risk.

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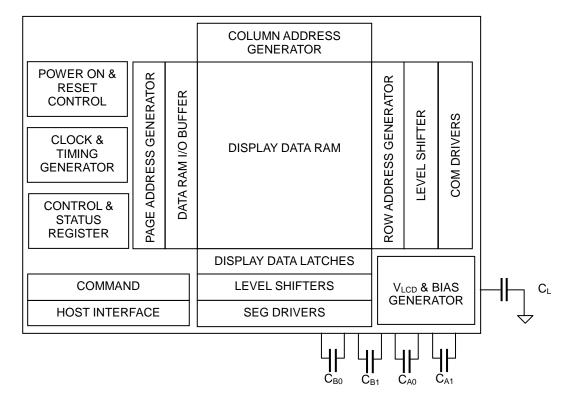
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BLOCK DIAGRAM





PIN DESCRIPTION

High-Voltage Mixed-Signal IC

Name	Туре	Pins	Description
			Main Power Supply
V _{DD} V _{DD2} V _{DD3}	PWR	11 10 4	V_{DD2}/V_{DD3} is the analog power supply and it should be connected to the same power source. V_{DD} is the digital power supply and it should be connected to a voltage source that is no higher than V_{DD2}/V_{DD3} . Please maintain the following relationship: $V_{DD}+1.5\ V \geqslant V_{DD2/3} \geqslant V_{DD}$ Minimize the trace resistance for V_{DD} and V_{DD2}/V_{DD3} .
V _{SS} V _{SS2}	GND	11 11	Ground. Connect V_{SS} and V_{SS2} to the shared GND pin. Minimize the trace resistance for V_{SS} and V_{SS2} .
			LCD Power Supply
V _{A0+} , V _{A0-} V _{A1+} , V _{A1-} V _{B0+} , V _{B0-} V _{B1+} , V _{B1-}	PWR	4, 4 4, 4 4, 4 4, 4	LCD Bias Voltages. These are the voltage sources to provide SEG driving currents. These voltages are generated internally. Connect capacitors of C _{AX} / C _{BX} value between V _{AX+} / V _{BX+} and V _{AX-} / V _{BX-} , respectively. The resistance of these traces directly affects the driving strength of SEG electrodes and impacts the image of the LCD module. Minimize the trace resistance is critical in achieving high quality image.
V _{LCD-IN}	PWR	2 2	High voltage LCD Power Supply. Connect these pins together.
V _{LCD-OUT}		2	A bypass capacitor C_L should be connected between V_{LCD} and V_{SS} . Keep the trace resistance under 30 Ω ~ 50 Ω .

Note:

Recommended capacitor values:

C_A, C_B: $100 \sim 250$ x LCD load capacitance or 5 μ F (5V), whichever is higher. C_L: 0.1μ F $\sim 0.5 \mu$ F (25V) is appropriate for most applications.

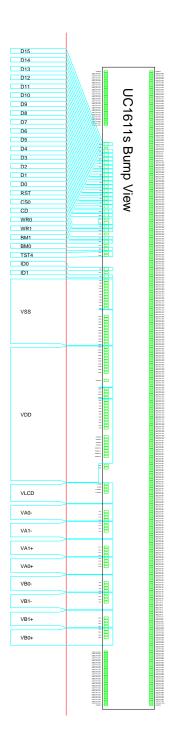
Name	Туре	Pins	Description													
Host Interface Bus Mode: The interface bus mode is determined by BM[1:0] and D[15,																
			Bus Mode: The with the follow						e is	dete	mine	d by	BM[[1:0] and	D[15	5, 13]
			Mod	de			BM[1:0]				DB1	5, DB	13			
			8080	10	6-bit			00			[Data				
			6800	10	ט-טונ			01			[Data				
			8080	0	-bit			10				00				
BM1~0	I	2	6800	O	-DIL			11				00				
			8080	4	-bit			10				01				
			6800	7	-DIL			11				01				
			4-wire S	PI (S	(88			10				10				
			3-wire S	PI (S	S9)			11				10				
			2-wire S	PI (l²	² C)			11				11				
CS1/A3 CS0/A2	I	2	Chip Selection chip is not se										CS0	= "L". W	hen	the
DOT			When RST=" states.	L", a	ıll cor	itro	l reg	ister	s ar	e re-	initial	ized	with	their def	ault	
RST	_	1	An RC filter h												erna	I RC
CD	I	1	Control data In S9 and I ² C "L": Contro	mo	des, (da CD	pin i	s no	t us	ed, c	ead/v onne data	vrite o	oper) pir	ration. n to V _{SS} .		
MDo			WR[1:0] cont Interface sec						erat	ion c	f the	host	inte	rface. Se	e Ho	st
WR0 WR1	I	1 1	In parallel mo 6800 mode o used. Conne	r 808	80 m	ode	. In s									
			Bi-directional to SCK, D[3]										l mo	odes, cor	nect	D[0]
				D15	D14 I	D13	D12	D11	D10	D9 [08 D7	D6 D	5 D4	D3 D2	D1	D0
			16-bit (BM=0x)								[15:0					
D45 D0			8-bit (BM=1x)	0	-	0	_	-	-		-		D	B[7:0]		
D15~D0	I/O	16	4-bit (BM=1x)	0	-	1	-	-	-		- -		-	DB	[3:0]	
			S8/S9 (BM=1x)	1	-	0	-	-	-	-	- -	- -	-	SDA -	- 5	SCK
			I ² C (BM=11)	1	-	1	-	-	-				-	SDA -	- 8	SCK
			Connect unus							le in	the <i>F</i>	lost l	nten	face sect	ion.	



Name	Туре	Pins	Description						
ID0	I	1	Production control. The connection will affect the content of ID when using the Get Status command. Connect to V_{DD} for "H" or V_{SS} for "L".						
ID1	I	1	SEG selection. Window commands will adjust its upper bound of column accordingly. 0: number of column is set to 256 (SEG0~255) 1: use SEG0~239 only and leave SEG240~255 open.						
HIGH VOLTAGE LCD DRIVER OUTPUT									
SEG1 ~ SEG256	HV	256	SEG (column) driver outputs. Support up to 256 columns. Leave unused drivers open-circuit.						
COM1~ COM160	HV	160	COM (row) driver outputs. Support up to 160 rows. Leave unused drivers open-circuit.						
			Misc. Pins						
V_{DDX}	0	5	Auxiliary V_{DD} . These pins are connected to the main V_{DD} bus on chip. They are provided to facilitate chip configurations in COG application. These pins should not be used to provide V_{DD} power to the chip. It is not necessary to connect V_{DDX} to main V_{DD} externally.						
TST4	I/HV	2	TST4 controls test mode and is also used to supply one of the high voltage required for MTP Program operation. Leave TST4 open during normal LCD operation. In COG applications keep TST4 trace resistance between 30 Ω ~ 50 Ω .						
TST2 TST1	I/O	1 1	Test I/O pins. Leave these pins open during normal use.						
Dummy		13	Dummy pins are <u>NOT</u> connected inside the IC.						

Note: Several control registers will specify "0-based index" for COM and SEG electrodes. In those situations, $COM_{\underline{X}}$ or $SEG_{\underline{X}}$ will correspond to index \underline{X} -1, and the value ranges for those index registers will be 0~159 for COM and 0~255 for SEG.

RECOMMENDED COG LAYOUT



Note for V_{DD} and V_{SS} with COG:

The operation condition, V_{DD} =1.8V (typical), should be satisfied under all operating conditions. UC1611s' peak current (I_{DD}) can be up to ~15mA during high speed data-write to UC1611s' on-chip SRAM. Such high pulsing current mandates very careful design of V_{DD} and V_{SS} ITO trances in COG modules. When V_{DD} and V_{SS} trace resistance is not low enough, the pulsing I_{DD} current can cause the actual on-chip V_{DD} to drop to below 1.65V and cause the IC to malfunction.



CONTROL REGISTERS

High-Voltage Mixed-Signal IC

UC1611s contains registers that control the chip operation. These registers can be modified by commands. The following table is a summary of the control registers, their meaning and their default value. Commands supported by UC1611s will be described in the next two sections. A summary table comes first and then followed by a detailed instruction-by-instruction description.

Name: The symbolic reference of the register.

Note that, some symbol names refer to bits (flags) within another register.

Default: Numbers shown in Bold font are default values after Power-Up-Reset and System-Reset.

Name	Bits	Default	Description
SL	8	00H	Scroll Line. Scroll the displayed image up by SL rows. The valid SL value are between 0 (for no scrolling) and (159 – FL). Setting SL outside of this range
			causes undefined effect on the displayed image.
FL	4	0H	Fixed lines. The first (FLx2) lines of each frame are fixed and are not affected by scrolling (SL). When FL is non-zero, the screen is effectively separated into two regions: one scrollable, one non-scrollable.
CA	8	00H	Display Data RAM Column Address (Used in Host to Display Data RAM access)
PA	7	00H	Display Data RAM Page Address (Used in Host for Display Data RAM access) When DC[5:3] = 100b, PA[6:5]: used to select Write Pattern 0~3. PA[4:0]: set SRAM page address
BR	2	2H	Bias Ratio. The ratio between V _{LCD} and V _{BIAS} . 00b: 5 01b: 10 10b: 11 11b: 12
TC	2	0H	Temperature Compensation (per °C). 00b: -0.05% 01b: -0.10% 10b: -0.15% 11b: 0.00%
PM	8	EAH	Electronic Potentiometer to fine tune V _{BIAS} and V _{LCD}
PMO	6	00H	PM offset. the effective PM value, PMV = PM - PMO[4:0] when PMO[5]=1 the effective PM value, PMV = PM + PMO[4:0] when PMO[5]=0
PC	4	FH	Pump Control. PC[1:0]: Panel Loading 00b: LCD: ≤33nF 11b: 33nF ≤ LCD≤55nF PC[3:2]: Pump Control 00b: External V _{LCD} 11b: Internal V _{LCD} (11x charge pump) (Setting to 01 or 10 will be invalid and default value will be used instead.)
AC	4	1H	Address Control: AC[0]: WA: Automatic column/page Wrap Around (Default 1:ON) AC[1]: Auto-Increment order 0: Column (CA) first 1: Page (PA) first AC[2]: PID: PA (page address) auto increment direction (0:+1, 1:-1) AC[3]: Window Program Mode 0: Inside Mode: Write to SRAM within the window defined by (WPC0,WPP0), (WPC1,WPP1) 1: Outside Mode: Write to SRAM but skip the window defined by (WPC0,WPP0), (WPC1,WPP1)

Name	Bits	Default	Description											
DC	8	18H	DC[1]: API DC[2]: Dis DC[4:3]: G 00: 10: DC[5]: Inp 0: 4 DC[7:6]: D 00:	V: Pixels Inversion: All Pixels Ol play ON/OFF (pray-shade Moron/Off mode 4-shade Mode ut Type of On/o-bit per 1-pixe	11: 1 Off Mode (enable I 1: 1- Selection (enabl 01: F	s-shade Mod 6-shade mode only when bott per 1-pix	de ode DC[4:3]=0 el	0b)						
LC	10	020H	LC[0]: MS LC[1]: MS LC[2]: MS LC[3]: Er	.CD Control: LC[0]: MSF: MSB First mapping Option (Default: 0:OFF) LC[1]: MX, Mirror X. SEG/Column sequence inversion (Default: 0:OFF) LC[2]: MY, Mirror Y. COM/Row sequence inversion (Default: 0:OFF) LC[3]: Enable FL lines in partial display mode.(Default: 0:OFF) LC[5:4]: Line Rate (= Frame-Rate x Mux-Rate)										
					LC[5:4]=00b	01b	10b	11b						
				16-shade 20.0 Klps 24.0 28.0 32.0										
				8-shade 14.1 16.9 19.7 22.5										
				4-shade	13.3	16.0	18.7	21.4						
				On/Off mode	5.9	7.1	8.2	9.4						
			LC[9:8] : 0xb			-1 (DST a	nd DEN are	er-second) e not used.)						
NIV	7	00H			sable N-line Inv									
CEN DST DEN	8 8 8	9FH 00H 9FH	Display ST Display EI Please ma CEN	Fart (the first of the first of the last CC aintain the follow	last COM with fuctive of the community o	scan pulse, an pulse, 0- :	0-based ir based inde	ndex)						
ISOF	4	1H	Set the IS	Olation clock in	Front of COM p	ulse.								
ISOB	4	0H	Set the IS	Olation clock in	Back of COM p	ulse.								
WPC0	8	00H	Window p	rogram starting	column address	s. Value ran	ge: 0 ~255.							
WPP0	7	00H		Window program starting page address. Value range: 0~79. When DC[5:3]=100b, value range: 0~19										
WPC1	8	FFH	Window p	Window program ending column address. Value range: 0~255.										
WPP1	7	4FH			page address. Vue range: 0~19	alue range:	0~79.							



Name	Bits	Default	Description
MTPC	6	10H	MTP Programming Control: MTPC[2:0]: MTP command 000: Idle 001: Read 010: Erase 011: Program 1xx: For UltraChip debug use only MTPC[3]: 0: MTP Disabled 1: Enabled (automatically cleared after each MTP command) MTPC[4]: Ignore/Use MTP. 0: Ignore 1: Use MTPC[5]: For testing only. Set to 0 for normal operation.
MTPM	6	00H	MTP Write Mask
			0: no action 1: program When MTPM[x]=1, the x-th bit of the MTP memory will be programmed to 1. MTPM[x]=0 means no write action for the x-th bit, and the content of this bit will not change.
APC	1	N/A	Advanced Product Configuration. For UltraChip only. Please do not use.
			Status Registers
ОМ	2	_	Operating Modes (Read Only) 00b: Reset 01b: (Not used) 10b: Sleep 11b: Normal
MD	1	_	MTP option flag. 0 : for non-MTP version. 1 : for MTP version
MS	1	_	MTP programming in-progress
WS	1	_	MTP Operation Succeeded

COMMAND TABLE

The following list of host commands is supported by UC1611s

0: Control 1: Data 0: Write cycle 1: Read cycle W/R:

Effective Data bits

Don't Care

	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Action	Default	
1.	Write Data Byte	1	0	#	#	#	#	#	#	#	#	Write 1 byte	N/A	
2.	Read Data Byte	1	1	#	#	#	#	#	#	#	#	Read 1 byte	N/A	
	,			Ver	MX	MY	WA	DE	WS	MD	MS	,		
3.	Get Status	0	1	ID[PMC				Get Status	N/A	
				_ •		t Cod	e	0	0	0	EF			
	Set Column Addr. LSB	0	0	0	0	0	0	#	#	#	#	Set CA[3:0]	0	
4.	Set Column Addr. MSB	0	0	0	0	0	1	#	#	#	#	Set CA[7:4]	0	
5.	Temp. Compensation.	0	0	0	0	1	0	0	1	#	#	Set TC[1:0]	00b: -0.05%/°C	
6.	Set Panel Loading	0	0	0	0	1	0	1	0	#	#	Set PC [1:0]	11b: 33~55 nF	
7.	Set Pump Control	0	0	0	0	1	0	1	1	#	#	Set PC [3:2]	11b	
	Set Adv. Program Control			0	0	1	1	0	0	R	R	Set APC[R][7:0]		
8.	(double-byte command)	0	0	#	#	#	#	#	#	#	#	R = 0~3	N/A	
	Set Scroll Line LSB			0	1	0	0	#	#	#	#	Set SL[3:0]	0	
9.	Set Scroll Line MSB	0	0	0	1	0	1	#	#	#	#	Set SL[7:4]	0	
	Set Page Address LSB			0	1	1	0	#	#	#	#	Set PA[3:0]	0	
10.	Set Page Address MSB	0	0	0	1	1	1	0	#	#	#	Set PA[6:4]	0	
	Set Potentiometer			1	0	0	0	0	0	0	1		514 5 111	
11.	(double-byte command)	0	0	#	#	#	#	#	#	#	#	Set PM[7:0]	PM=EAH	
	,			1	0	0	0	0	0	1	0			
12.	Set Isolation Clock Front	0	0	0	0	0	1	0	0	1	1	Set ISOF[3:0]	1H	
				-	-	-	-	#	#	#	#			
				1	0	0	0	0	0	1	0			
13.	Set Isolation Clock Back	0	0	0	0	0	1	0	1	0	0	Set ISOB[3:0]	0H	
				-	-	-	_	#	#	#	#		• • • • • • • • • • • • • • • • • • • •	
14.	Set Partial Display Control	0	0	1	0	0	0	0	1	#	#	Set LC[9:8]	00b: Disable	
15.	Set RAM Address Control	0	0	1	0	0	0	1	#	#	#	Set AC[2:0]	001b	
16.	Set Fixed Lines	0	0	1	0	0	1	#	#	#	#	Set FL[3:0]	0	
17.	Set Line Rate	0	0	1	0	1	0	0	0	#	#	Set LC[5:4]	10b:28klps	
18.	Set All-Pixel-ON	0	0	1	0	1	0	0	1	0	#	Set DC[1]	0	
19.	Set Inverse Display	0	0	1	0	1	0	0	1	1	#	Set DC[0]	0	
20.	' '	0	0	1	0	1	0	1	#	#	#	Set DC[4:2]	110b	
04	Set LCD Mapping Control	_		1	1	0	0	0	0	0	0		0	
21.	(double-byte command)	0	0	0	0	0	0	#	#	#	#	Set LC[3:0]	0	
	Set N-line Inversion	_		1	1	0	0	1	0	0	0	0 () 110 (50 0)	0011	
22.	(double-byte command)	0	0	-	#	#	#	#	#	#	#	Set NIV[6:0]	00H	
23.	Set Display Pattern	0	0	1	1	0	1	0	#	#	#	Set DC[7:5]	000b	
24.	System Reset	0	0	1	1	1	0	0	0	1	0	System Reset	N/A	
25.	NOP	0	0	1	1	1	0	0	0	1	1	No operation	N/A	
	Set test control	0	0	1	1	1	0	0	1	Т	Т	For testing only.		
26.	(double-byte command)	0	0	#	#	#	#	#	#	#	#	Do not use.	N/A	
27.	Set LCD Bias Ratio	0	0	1	1	1	0	1	0	#	#	Set BR[1:0]	10b: 11	
20		0	0	1	1	1	1	0	0	0	1			
28.	Set COM End	0	0	#	#	#	#	#	#	#	#	Set CEN[7:0]	159	
20	Set Partial Display Start	0	0	1	1	1	1	0	0	1	0	Set DST[7:0]	0	
29.	Set Fattial Display Staff	0	0	#	#	#	#	#	#	#	#	Set DST[7:0]	U	
30	Set Partial Display End	0	0	1	1	1	1	0	0	1	1	Set DEN[7:0]	159	
<i>0</i> 0.	Cot i diddi Display Elia	0	0	#	#	#	#	#	#	#	#	OCC DE14[7.0]	100	



	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Actio	n	Default
31.	Set Window Program Starting Column Address	0	0	1 #	1 #	1 #	1 #	0	1 #	0 #	0 #		Set WPC0	0
32.	Set Window Program Starting Page Address	0	0	1 -	1 #	1 #	1 #	0 #	1 #	0 #	1 #	Shared with	Set WPP0	0
33.	Set Window Program Ending Column Address	0	0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	0 #	MTP Commands	Set WPC1	255
34.	Set Window Program Ending Page Address	0	0	1 -	1 #	1 #	1 #	0 #	1 #	1 #	1 #		Set WPP1	79
35.	Set Window Program Mode	0	0	1	1	1	1	1	0	0	#	Set AC[3]		0:Inside
36.	Set MTP Operation Control	0	0	1 -	0	1 #	1 #	1 #	0 #	0 #	0 #	Set MTPC[5:0]		10H
37.	Set MTP Write Mask	0	0	1 -	0	1 #	1 #	1 #	0 #	0 #	1 #	Set MTPM[5:0]		0
38.	Set V _{MTP1} Potentiometer	0	0	1 #	1 #	1 #	1 #	0 #	1 #	0 #	0 #		Set MTP1	N/A
39.	Set V _{MTP2} Potentiometer	0	0	1 #	1 #	1 #	1 #	0 #	1 #	0 #	1 #	Shared with Window	Set MTP2	N/A
40.	Set MTP Write Timer	0	0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	0 #	Program Commands	Set MTP3	N/A
41.	Set MTP Read Timer	0	0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	1 #		Set MTP4	N/A
	S	ERIA	REAL	Сом	MAND	(ENAI	BLE IN	S 8 o	R S9 I	Bus N	IODES	ONLY)		
42.	Get Status	-	1	1 Ver ID[1 MY	1 WA		1 WS [5:0]	1 MD	0 MS	Get Status Disab		N/A
				Р	roduc	t Cod	е	0	0	0	EF			

Notes:

- All bit patterns other than commands listed above may result in undefined behavior.
- Commands (38)~(41) are shared with commands (31)~(34), and have exactly the same code. When MTPC[3]=0, commands (37)~(41) are interpreted as Window Programming commands. When MTPC[3]=1, they are MTP Control commands.
- MTPM and PM are actually the same register. Only one of the commands (36) is valid at any time, and it is determined by MTPC[3].
- After MTP-ERASE or MTP-PROGRAM operation, please always perform the following steps,
 - a) Disconnect TST4 power source.
 - b) Do a full V_{DD} ON-OFF cycle (make sure V_{DD} drops below 50mV). before resuming normal operation.

COMMAND DESCRIPTIONS

(1) WRITE DATA TO DISPLAY MEMORY

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Write data	1	0			8-bit [Data-W	rite to S	SRAM		

(2) READ DATA FROM DISPLAY MEMORY

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Read data	1	1	8-bit Data-Read from SRAM							

Write/Read Data Byte (command 1, 2) operation accesses display buffer RAM based on Page Address (PA) register and Column Address (CA) register. To minimize bus interface cycles, PA and CA will increase or decrease automatically after each bus cycle, depending on the setting of Access Control (AC) register. PA and CA can also be programmed directly by issuing Set Page Address and Set Column Address commands.

If \underline{W} rap- \underline{A} round (WA) is OFF (AC[0] = 0), CA will stop increasing after reaching the end of page, and system programmers need to set the values of PA and CA explicitly. If WA is ON (AC[0]=1), when CA reaches end of page, CA will be reset to 0 and PA will be increased or decreased by 1, depending on the setting of \underline{P} age \underline{I} increment \underline{D} irection (PID, AC[2]). When PA reaches the boundary of RAM (i.e. PA = 0 or 79), PA will be wrapped around to the other end of RAM and continue.

For both 8-bit and 16-bit interfaces, the first 1 byte and 2 bytes Read respectively is a dummy Read. Please ignore the data read out.

(3) GET STATUS SUMMARY

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
			Ver	MX	MY	WA	DE	WS	MD	MS
Get Status	0	1	ID[1:0]			PMC	[5:0]		
				Produc	t Code		0	0	0	EF

Status 1 definitions:

Ver: Version Code. 1

MX: Status of register LC[1], mirror X.MY: Status of register LC[2], mirror Y.

WA: Status of register AC[0]. Automatic column/row wrap around.

DE: Display enable flag. DE=1 when display is enabled

WS: MTP Command Succeeded

MD: MTP Option (Yes/No)

MS: MTP action status

Status 2 definitions:

ID: Connection Status of the ID pin, could be used for production identifying.

PMO[5:0]: PM offset value

Status 3 definitions:

Product Code: 1h

EF: ESD Flag. EF=1 when ESD strikes.

If multiple Get Status commands are issued consecutively within one single CD 1⇒0⇒1 transaction, the Get Status command will return {Status1, Status2, Status3, Status1, Status2, Status3, Status1..} alternately.



(4) SET COLUMN ADDRESS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Column Address LSB CA[3:0]	0	0	0	0	0	0	CA3	CA2	CA1	CA0
Set Column Address MSB CA[4:7]	0	0	0	0	0	1	CA7	CA6	CA5	CA4

Set the SRAM column address for read/write access.

CA possible value: 0 ~ 255

(5) SET TEMPERATURE COMPENSATION

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Temperature Compensation TC[1:0]	0	0	0	0	1	0	0	1	TC1	TC0

Set V_{BIAS} Temperature compensation coefficient (%-per-degree-C) for all 4 temperature compensation curves.

Temperature compensation curve definition:

(6) SET PANEL LOADING

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Panel Loading PC[1:0]	0	0	0	0	1	0	1	0	PC1	PC0

Set PC[1:0] according to the capacitance loading of LCD panel.

Panel loading definition: $00b : LCD \le 33nF$ $11b : 33 nF \le LCD \le 55 nF$

(7) SET PUMP CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Pump Control PC[3:2]	0	0	0	0	1	0	1	1	PC3	PC2

Set PC[3:2] to program the build-in charge pump stages.

00b=External V_{LCD} 11b= Internal V_{LCD} (11x charge pump)

(8) SET ADVANCED PROGRAM CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set APC[R][7:0]	0	0	0	0	1	1	0	0	0	R
(Double byte command)	0	0			APC[F	R] regis	ter para	meter		

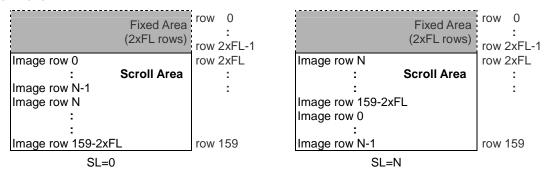
For UltraChip only. Please do NOT use.

(9) SET SCROLL LINE

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Scroll Line LSB SL[3:0]	0	0	0	1	0	0	SL3	SL2	SL1	SL0
Set Scroll Line MSB SL[7:4]	0	0	0	1	0	1	SL7	SL6	SL5	SL4

Set the number of lines for scroll area.

The scroll line setting will scroll the displayed image up by SL rows. The valid value for SL is between 0 (no scrolling) and 159-2x(FL) (full scrolling). FL is the register value programmed by the Set Fixed Lines command.



(10) SET PAGE ADDRESS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Page Address LSB PA [3:0]	0	0	0	1	1	0	PA3	PA2	PA1	PA0
Set Page Address MSB PA [6:4]	0	0	0	1	1	1	0	PA6	PA5	PA4

Set SRAM page address for read/write access. UC1611s can store 4 B/W mode pictures in SRAM. Set PA[6:5] to specify which one to store. (Also refer to command "Set Display Mode".)

Possible value = 0 ~ 79

When On/Off mode and DC[5]=1

PA[6:5]: select Write Pattern0(00b) ~ Write Pattern3(11b)

PA[4:0]: set SRAM page address

(11) SET POTENTIOMETER

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Potentiometer PM [7:0]	0	0	1	0	0	0	0	0	0	1
(Double-byte command)	0	0				PM[7:0]			

Program V_{BIAS} Potentiometer (PM[7:0]). See section *LCD Voltage Setting* for more detail.

Effective range of PM value = 0 ~ 255 (Default : 234)

(12) SET ISOLATION CLOCK FRONT

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
0 11 11 01 15 11005 6 01	0	0	1	0	0	0	0	0	1	0
Set Isolation Clock Front ISOF [3:0] (Triple-byte command)	0	0	0	0	0	1	0	0	1	1
(The Byte command)	0	0	-	-	-	-		ISOF	[3:0]	

Program isolation clock in front of COM pulse.

Effective range of ISOF value = $0 \sim 15$ (Default : 1)



(13) SET ISOLATION CLOCK BACK

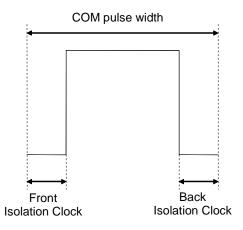
High-Voltage Mixed-Signal IC

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Oat lastice Olast Dark 1000 (0.01	0	0	1	0	0	0	0	0	1	0
Set Isolation Clock Back ISOB [3:0] (Triple-byte command)	0	0	0	0	0	1	0	1	0	0
(Thiple Byte commune)	0	0	-	-	-	-		ISOE	3[3:0]	

Program isolation clock in back of COM pulse.

Effective range of ISOB value = 0 ~ 15 (Default: 0)

Note: Use higher V_{LCD} when increase isolation clock.



(14) SET PARTIAL DISPLAY CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Partial Display Control LC [9:8]	0	0	1	0	0	0	0	1	LC9	LC8

This command is used to control partial display function.

LC[9:8]: **0xb: Disable Partial Display**, Mux-Rate = CEN+1 (DST and DEN are not used.) 11b: Enable Partial Display, Mux-Rate = DEN-DST+1+LC[3]xFLx2

(15) SET RAM ADDRESS CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set AC [2:0]	0	0	1	0	0	0	1	AC2	AC1	AC0

Program registers AC[2:0] for RAM address control.

AC[0]: WA, Automatic column/page wrap around.

0: CA or PA (depends on AC[1]= 0 or 1) will stop incrementing after reaching boundary

1: CA or PA (depends on AC[1]= 0 or 1) will restart, and PA or CA will increment by one step.

AC[1]: Auto-Increment order

0: column (CA) increases (+1) first until CA reach CA boundary, then PA will increase by (+/-1).

1 : page (PA) increases (+/-1) first until PA reach PA boundary, then CA will increase by (+1).

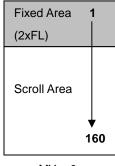
AC[2]: PID, page address (PA) auto increment direction ($\mathbf{0}/1 = +/-1$)

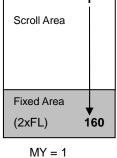
When WA=1 and CA reaches CA boundary(CA=MC), PID controls whether page address will be adjusted by increasing +1 or -1. If WA is 0, the column address will stay in MC value and the page address will stay unchanged.

(16) SET FIXED LINES

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Fixed Lines FL [3:0]	0	0	1	0	0	1	FL3	FL2	FL1	FL0

The Fixed Lines function is used to implement the partial scroll function by dividing the screen into scroll and fixed area. The Set Fixed Lines command will define the fixed area, which will not be affected by the SL scroll function. When MY=0, the fixed area covers the top 2xFL rows; when MY=1, the bottom 2xFL rows. One example of the visual effect on LCD is illustrated in the figure below. Default: 0.





MY = 0

IVIN

(17) SET LINE RATE

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Line Rate LC [5:4]	0	0	1	0	1	0	0	0	LC5	LC4

Program LC [5:4] for line rate setting (Line-Rate = Frame-Rate x Mux-Rate)

In 16-shade mode:	00b : 20.0 Klps	01b : 24.0 Klps	10b : 28.0 Klps	11b : 32.0 Klps
In 8-shade mode:	00b : 14.1 Klps	01b : 16.9 Klps	10b : 19.7 Klps	11b : 22.5 Klps
In 4-shade mode:	00b : 13.3 Klps	01b : 16.0 Klps	10b : 18.7 Klps	11b : 21.4 Klps
In On/Off mode:	00b: 5.9 Klps	01b: 7.1 Klps	10b: 8.2 Klps	11b: 9.4 Klps

(Klps: Kilo-line per second)

(18) SET ALL PIXEL ON

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set All Pixel ON DC [1]	0	0	1	0	1	0	0	1	0	DC1

Set DC[1] to force all SEG drivers to output ON signals. This function has no effect on the existing data stored in display RAM. Default: **0**.

(19) SET INVERSE DISPLAY (PXV)

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Inverse Display DC [0]	0	0	1	0	1	0	0	1	1	DC0

Set DC[0] to force all SEG drivers to output the inverse of the data (bit-wise) stored in display RAM. This function has no effect on the existing data stored in display RAM. Default: **0**.



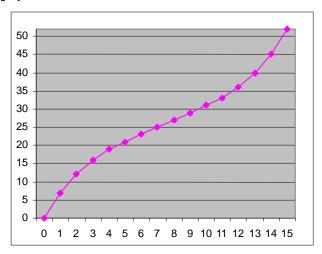
(20) SET DISPLAY ENABLE

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Display Enable DC[4:2]	0	0	1	0	1	0	1	DC4	DC3	DC2

This command is for programming register DC[4:2]. Default: 110b.

When DC[2] is set to **0**, the IC will put itself into Sleep mode. All drivers, voltage generation circuit and timing circuit will be halted to conserve power. When DC[2] is set to 1, UC1611s will first exit from Sleep mode, restore the power and then turn on COM drivers and SEG drivers. There is no other explicit user action or timing sequence required to enter or exit the Sleep mode.

DC[4:3] controls the gray shade modulation modes. UC1611s has four gray shade modulation modes: an On/Off mode 8-shade mode, 4-shade mode and a 16-shade mode. The modulation curves are shown below. Horizontal axes are the gray shade data. The vertical axes are the ON-OFF ratio.



Effective range:

ive range.									
DC[4:3]	Gray-Scale	D7	D6	D5	D4	D3	D2	D1	D0
00 DC[5]=1	B/W Mode	1	0	1	0	1	0	1	0
DC[5]=0	D/VV IVIOGE	1				0	-	ı	-
		1	1	1	-	0	0	0	-
01	8-shade	1	1	0	-	0	0	1	-
01	o-snaue	1	0	1	-	0	1	0	-
		1	0	0	-	0	1	1	-
10	4-shade	1	1			0	0		-
10	4-511aue	1	0	-	-	0	1	ı	-
		1	1	1	1	0	0	0	0
		1	1	1	0	0	0	0	1
		1	1	0	1	0	0	1	0
11	16-shade	1	1	0	0	0	0	1	1
"	10-Silaue	1	0	1	1	0	1	0	0
		1	0	1	0	0	1	0	1
		1	0	0	1	0	1	1	0
		1	0	0	0	0	1	1	1

MSF=0: RAM_D[7:4] = B[7:4], RAM_D[3:0] = B[3:0] MSF=1: RAM_D[7:4] = B[3:0], RAM_D[3:0] = B[7:4]

(21) SET LCD MAPPING CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set LCD Mapping Control LC[3:0]	0	0 0	1	1	0	0	0	0	0	0
(Double-byte command)	Ü	U	0	0	0	0	LC3	MY	MX	MSF

Set LC[2:0] for COM (row) mirror (MY), SEG (column) mirror (MX) and MSB first or LSB first options (MSF).

MY is implemented by reversing the mapping order between RAM and COM (row) electrodes. The data stored in RAM is not affected by MY command. MY will have immediate effect on the display image.

MX is implemented by selecting the CA or 255-CA as write/read (from host interface) display RAM column address so this function will only take effect after rewriting the RAM data.

MSF is implemented by MSB-LSB swapping. The operation is determined by DC[4:3], as described in Set Gray Scale Mode command below.

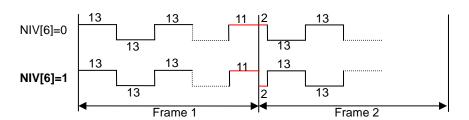
LC[3] controls whether the soft icon section (FL on the top) will be displayed during partial display mode.

(22) SET N-LINE INVERSION

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set N-line Inversion NIV [6:0]	0	0	1	1	0	0	1	0	0	0
(Double-byte command)	"	U	-			١	NIV [6:0)]		

Set N-Line inversion:

NIV[6]: **0b: non-XOR** 1b: XO



(23) SET DISPLAY PATTERN

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Display Pattern	0	0	1	1	0	1	0		DC[7:5]]

Set Display Pattern Selection: (enabled only when DC[4:3]=00b)

DC[5]: Input type for On/Off mode

0:4 bits for 1 pixel

1:1 bit for 1 pixel

DC[7:6]: Select Display Pattern (Only enable when On/Off mode and DC[5:3] =100b)

00 : Pattern0 01 : Pattern1 10 : Pattern2 11 : Pattern3

UC1611s can store 4 different patterns in SRAM when DC[5:3]=100. Set PA[6:5] and DC[7:6] to select which pattern to store / display, respectively.

(24) SYSTEM RESET

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
System Reset	0	0	1	1	1	0	0	0	1	0

This command will activate the system reset. Control register values will be reset to their default values. Data stored in RAM will not be affected.



(25) NOP

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
No operation	0	0	1	1	1	0	0	0	1	1

This command is used for "no operation".

(26) SET TEST CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set TT	0	0	1	1	1	0	0	1	Т	T
(Double byte command)	0	0 Testing parameter								

This command is used for UltraChip production testing. For UltraChip only. Please do NOT use.

(27) SET LCD BIAS RATIO

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Bias Ratio BR [1:0]	0	0	1	1	1	0	1	0	BR1	BR0

Bias ratio definition: 00b= 5 01b=10 **10b**=11 11b=12

(28) SET COM END

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set CEN [7:0]	0	0	1	1	1	1	0	0	0	1
(Double byte command)	0	0			CEN	registe	r paran	neter		

This command programs the ending COM electrode. CEN defines the number of used COM electrodes, and it should correspond to the number of pixel-rows in the LCD.

(29) SET DISPLAY START

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set DST [7:0]	0	0	1	1	1	1	0	0	1	0
(Double byte command)	0	0			DST	registe	r paran	neter		

This command programs the starting COM electrode, which has been assigned a full scanning period, and which will output active COM scanning pulses.

(30) SET DISPLAY END

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set DEN [7:0]	0	0	1	1	1	1	0	0	1	1
(Double-byte command)	U	U			DEN	registe	r parar	neter		

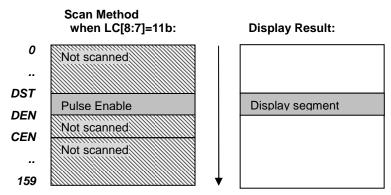
This command programs the ending COM electrode, which has been assigned a full scanning period, and which will output an active COM scanning pulse.

CEN, DST, and DEN are 0-based indexes of COM electrodes. They control only the COM electrode activity, and do not affect the mapping of display RAM to each COM electrodes. The image displayed by each pixel row is therefore not affected by the setting of these three registers.

When LC[8:7]=11b, the Mux-Rate is narrowed down to DST-CEN+1+(LC[3]xFLx2). When MUS rate is reduced, reduce the line rate accordingly to reduce power. Changing MUX rate also require BR and VLCD to be reduced.

For minimum power consumption, set LC[8:7]=11b, set (DST, DEN, FL, CEN) to minimize MUX rate, use slowest line rate which satisfies the flicker requirement, use On/Off mode, set PC[1:0]=00b, disable N-line Inversion, and use lowest BR, lowest VLcD which satisfies the contrast requirement. When Mux-Rate is under 40, it is recommended to set BR=5 for optimum power saving.

In either case, DST/DEN defines a small subsection of the display which will remain active while shutting down all the rest of the display to conserve energy.





(31) SET WINDOW PROGRAM STARTING COLUMN ADDRESS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set WPC0 [7:0]	0	0	1	1	1	1	0	1	0	0
(Double-byte command)	0	0			WPC) regist	er para	meter		

This command is to program the starting column address of RAM program window.

(32) SET WINDOW PROGRAM STARTING PAGE ADDRESS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set WPP0 [6:0]	0	0	1	1	1	1	0	1	0	1
(Double-byte command)	0	0	-		W	PP0 re	gister p	aramet	er	

This command is to program the starting page address of RAM program window.

(33) SET WINDOW PROGRAM ENDING COLUMN ADDRESS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set WPC1 [7:0]	0	0	1	1	1	1	0	1	1	0
(Double-byte command)	0	0			WPC ²	1 regist	er para	meter		

This command is to program the ending column address of RAM program window.

(34) SET WINDOW PROGRAM ENDING PAGE ADDRESS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set WPP1 [6:0]	0	0	1	1	1	1	0	1	1	1
(Double-byte command)	0	0	-		W	PP1 re	gister p	aramet	er	

This command is to program the ending page address of RAM program window.

(35) SET WINDOW PROGRAM MODE

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set Window Program Enable AC[3]	0	0	1	1	1	1	1	0	0	AC3

This command controls the Window Program function.

0: Inside Mode 1: Outside Mode

Setting or resetting AC[3] does not affect the values of CA and PA. So, always remember to reposition CA and PA properly after changing the setting of AC[3].

When using Outside mode, the data inside window will be ignored, that is, users can send data of full screen.

Display Data	Function	Setting	Image in Display Data RAM
Direction	MX, LC[1]	RID, AC[2]	(Physical origin: upper left corner)
Normal	0	0	
Y-mirror	0	1	
X-mirror	1	0	
X-mirror Y-mirror	1	1	120

(36) SET MTP CONTROL

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set MTPC[5:0]	0	0	1	0	1	1	1	0	0	0
(Double-byte command)	0	0	-	-	MTPC register parameter					

This command is for MTP operation control:

MTPC[2:0] : MTP command

 000 : Idle
 001 : MTP Read

 010 : MTP Erase
 011 : MTP Program

1xx : For UltraChip use only.

MTPC[3]: MTP Enable (Automatically cleared each time after MTP command is done)

MTPC[4]: MTP value valid (Ignore MTP value when L) MTPC[5]: For testing only. Set to 0 for normal operation



The following commands (37)~(41) are only valid when MTPC[3]=1.

DC[2] and MTPC[3] are mutually exclusive. Only one of these two control flags can be set to ON at any time. In other words, when DC[2] is ON, all MTP operations will be blocked, and, when MTP operation is active, set DC[2] to 1 will be blocked.

(37) SET MTP WRITE MASK

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set MTPM[5:0]	0	0	1	0	1	1	1	0	0	1
(Double-byte command)	0	0	-	-		MTPN	/I regist	er para	meter	

This command enables Write to each individual MTP bits.

When MTPM[x]=1, the x-th bit of the MTP memory will be programmed to "1". MTPM[x]=0 means no write action for x-th bit. And the content of this bit will not change.

The amount of "programming current" increases with the number of 1's in MTPM. If the "programming current" appears to be too high for the LCM design (e.g. TST4 ITO trace is not wide enough to supply the current), use multiple write cycles and distribute the 1's evenly into these cycles.

MTPM[5:0]: Set PMO value

(38) SET V_{MTP1} POTENTIOMETER

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set MTP1	0	0	1	1	1	1	0	1	0	0
(Double-byte command)		0	Shared register parameter							

This command is for fine tuning V_{MPT1} setting (with BR=00) and is valid only when MTPC[3]=1.

(39) SET V_{MTP2} POTENTIOMETER

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set MTP2	0	0	1	1	1	1	0	1	0	1
(Double-byte command)	0	0			Share	d regist	er para	meter		

This command is for fine tuning V_{MTP2} PM setting (with BR=11) and is valid only when MTPC[3]=1.

(40) SET MTP WRITE TIMER

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set MTP3	0	0	1	1	1	1	0	1	1	0
(Double-byte command)	0	0			Share	d regist	er para	meter		

(41) SET MTP READ TIMER

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
Set MTP4	0	0	1	1	1	1	0	1	1	1
(Double-byte command)	0	0			Share	d regist	ter para	meter		

Serial Read Commands (for S8 or S9 Bus mode only):

(42) GET STATUS

Action	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	1	1	1	1	1	1	1	0
Get Status	-		Ver	MX	MY	WA	DE	WS	MD	MS
Get Status		1	ID[1:0]			PMC	[5:0]		
		ľ		Produc	t Code		0	0	0	EF

LCD VOLTAGE SETTING

MULTIPLEX RATES

Multiplex Rate (*MR*) is completely software programmable in UC1611s via the register CEN.

Combined with low power partial display mode and a low bias ratio of 5, UC1611s can support wide variety of display control options. For example, when a system goes into stand-by mode, a large portion of LCD screen can be turned off to conserve power.

BIAS RATIO SELECTION

Bias Ratio (BR) is defined as the ratio between V_{LCD} and V_{REF} , i.e.

$$BR = V_{LCD}/V_{REF}$$
,
where $V_{REF} = V_{A1P} - V_{A1N}$

The theoretical optimum $Bias\ Ratio\ can$ be estimated by $\sqrt{Mux}+1$. BR of value 15~20% lower/higher than the optimum value calculated above will not cause significant visible change in image quality.

Due to the nature of STN operation, an LCD designed for good gray-shade performance at high Mux Rate (e.g. MR=160), can generally perform very well as a black and white display, at lower Mux Rate. However, it is also true that such technique generally cannot maintain LCD's quality of gray shade performance, since the contrast of the LCD will increase as Mux Rate decreases, and the shades near the two ends of the spectrum will start to lose visibility.

UC1611s supports four *BR* as listed below. BR can be selected by software program.

BR	0	1	2	3
Bias Ratio	5	10	11	12

Table 1: Bias Ratios

TEMPERATURE COMPENSATION

Four (4) different temperature compensation coefficients can be selected via software. The four coefficients are given below:

TC	0	1	2	3
% per °C	-0.05	-0.10	-0.15	0.00

 Table 2: Temperature Compensation

V_{LCD} GENERATION

V_{LCD} may be supplied either by internal charge pump or by external power supply. The source of V_{LCD} is controlled by PC[3:2]. For good product reliability, it is recommended to keep V_{LCD} under 17.5V over the entire operating range.

When V_{LCD} is generated internally, the voltage level of V_{LCD} is determined by three control registers: BR (Bias Ratio), PM (Potentiometer), and TC (Temperature Compensation), with the following relationship:

$$V_{LCD} = (C_{V0} + C_{PM} \times PM) \times (1 + (T - 25) \times C_T \%)$$
 where

C_{V0} and C_{PM} are two constants, whose value depends on the BR register setting. The values are provided in the table in the next page,

PM is the numerical value of PM register,

T is the ambient temperature in ${}^{\circ}C$, and

 C_T is the temperature compensation coefficient as selected by TC register.

V_{LCD} FINE TUNING

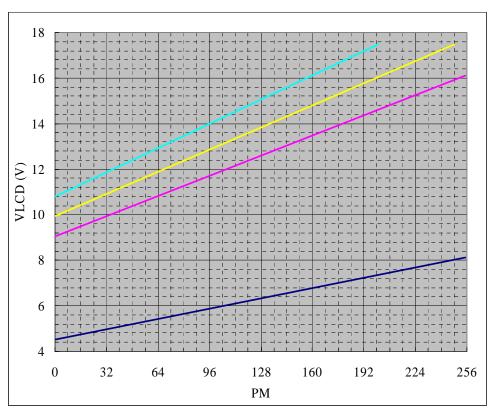
Gray shade and color STN LCD is sensitive to even a 1% mismatch between IC driving voltage and the V_{OP} of LCD. However, it is difficult for LCD makers to guarantee such high precision matching of parts from different venders. It is therefore necessary to adjust V_{LCD} to match the actual V_{OP} of the LCD.

For best result, software or MTP based V_{LCD} adjustment is the recommended method for V_{LCD} fine-tuning. System designers should always consider the contrast fine tuning requirement before finalizing on the LCM design.

LOAD DRIVING STRENGTH

The power supply circuits of UC1611s are designed to handle LCD panels with load capacitance up to 40nF at V_{LCD} =17V when V_{DD2} =2.8V. For larger LCD panels or higher V_{LCD} , use higher $V_{DD2/3}$.

V_{LCD} QUICK REFERENCE



 V_{LCD} -PM relationship for different BR setting at 25°C.

BR	C _{V0} (V)	C _{PM} (mV)	PM_reg	V _{LCD} (V)
5	4.518	14.19	0	4.52
5	4.516	14.19	255	8.14
10	9.048	27.68	0	9.05
10	9.046	27.00	255	16.11
11	9.925	30.48	0	9.92
''	9.925	30.46	248	17.48
12	12 10.791 3		0	10.79
12	10.791	33.25	201	17.47

Note:

- For good product reliability, keep V_{LCD} (max) under 17.5V under all operating temperature.
 The integer values of BR above are for reference only and may have slight shift.

HI-V GENERATOR AND BIAS REFERENCE CIRCUIT

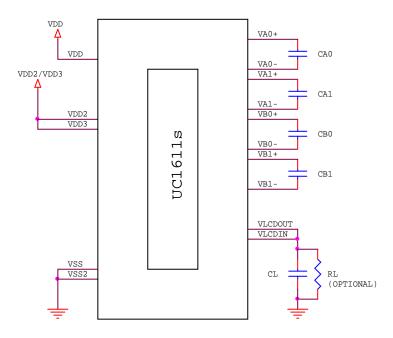


FIGURE 1: Reference circuit using internal Hi-V generator circuit

Note

Recommended component values:

100~250 x LCD load capacitance or $5\mu F$ (5V), whichever is higher. $0.1\mu F$ ~0.5 μF (25V) is appropriate for most applications. C_A , C_B :

 C_L :

 $3.3M \sim 10M\Omega$ Acts as a draining circuit when the power is abnormally shut down. R_L:

LCD DISPLAY CONTROLS

CLOCK & TIMING GENERATOR

UC1611s contains a built-in system clock. All required components for the clock oscillator are built-in. No external parts are required.

Eight different line rates are provided for system design flexibility. The line rate is controlled by register LC[5:4]. When Mux-Rate is above 108, frame rate is calculated as:

Frame rate = Line-Rate / Mux-Rate.

When Mux-Rate is under 107, 80, 53, 40, Line rate will automatically be scaled down by 1.5, 2, 3, 4 respectively to reduce power consumption.

Flicker-free frame rate is dependent on LC material and gray-shade modulation scheme. Frame rate ≥ 150Hz is recommended for 16-shade mode. Choose lower frame rate for lower power, and choose higher frame rate to improve LCD contrast and minimize flicker.

DRIVER MODES

COM and SEG drivers can be in either Idle mode or Active mode, controlled by Display Enable flag (DC[2]). When SEG drivers are in idle mode, they will be connected together to ensure zero DC condition on the LCD.

DRIVER ARRANGEMENTS

The naming conventions are: COM(x), where $x = 1\sim160$, refers to the COM driver for the x-th row of pixels on the LCD panel.

The mapping of COM(x) to LCD pixel rows is fixed and it is not affected by SL, CST, CEN, DST, DEN, MX or MY settings.

DISPLAY CONTROLS

There are three groups of display control flags in the control register DC: Driver Enable (DE), All-Pixel-ON (APO), and Inverse (PXV). DE has the overriding effect over PXV and APO.

DRIVER ENABLE (DE)

Driver Enable is controlled by the value of DC[2] via Set Display ON command. When DC[2] is set to OFF (logic "0"), both COM and SEG drivers will become idle and UC1611s will put itself into Sleep mode to conserve power.

When DC[2] is set to ON, the DE flag will become "1", and UC1611s will first exit from Sleep mode, restore the power (V_{LCD} , V_D , etc.) and then turn on COM and DEG drivers.

ALL PIXELS ON (APO)

When set, this flag will force all active SEG drivers to output On signals, disregarding the data stored in the display buffer.

This flag has no effect when Display Enable is OFF and it has no effect on data stored in RAM.

INVERSE (PXV)

When this flag is set to ON, active SEG drivers will output the inverse of the value it received from the display buffer RAM. This flag has no impact on data stored in RAM.

PARTIAL SCROLL

The control register FL specifies a region of rows those are not affected by the SL register. Since SL register can be used to implement scroll function. The FL register can be used to implement fixed region when the other part of the display is scrolled by SL.

PARTIAL DISPLAY

UC1611s provides flexible control of Mux Rate and active display area. Please refer to command Set COM End, Set Partial Display Start, and Set Partial Display End for more detail.

GRAY-SHADE MODULATION MODE

UC1611s has two gray-shade modulation modes: 16-shade, 8-shade, 4-shade and On/Off mode.

The On/Off mode will consume roughly 40~45% less power than the 16-shade mode, and can be used for situations where power consumption is more critical than color fidelity.

Changing gray-shade modulation mode does not affect the content of SRAM display buffer, and the image data will remain the same after switching back and forth between On/Off mode and 16-shade mode.

LAYOUT CONSIDERATIONS FOR COM SIGNALS

Under 16-gray-shade mode, the COM scanning pulses of UC1611s can be as short as $17\mu s$. Since COM distortion can lead to reduction of effective duty factor of the LCM, it is critical to control the RC delay of COM signal to minimize distortion of COM scanning pulse.

For the best image quality, limit the worst case RC delay of COM signal as calculated below.

 $RC_{COM} = (R_{ROW} / 3 + R_{COM} + R_{OUT}) \times C_{ROW}$ $RC_{COM-MAX} \le 1.2 \mu S$

where

C_{ROW}: LCD loading capacitance of one

row of pixels. It can be calculated by $C_{\text{\tiny LCD}}/\text{Mux-Rate},$ where $C_{\text{\tiny LCD}}$ is

the LCD panel capacitance.

R_{ROW}: ITO resistance over one row of

pixels within the active area

R_{COM}: COM routing resistance from IC to

the active area (COF+ITO routing)

R_{OUT}: COM driver output impedance

In case RC_{COM-MAX} exceed the above constraint significantly, please make sure

$$|RC_{COM-MAX} - RC_{COM-MIN}| < 0.6 \mu S$$

so that the COM scan pulse distortions from the top of the screen to the bottom of the screen are uniform.

For 8-gray-shade mode, the COM scanning pulse is about 35% slower than the 16-gray-shade mode. Therefore, the two constraints described above can be relaxed by 1/3 respectively to

$$RC_{COM} \le 1.6uS$$

| $RC_{COM-MAX} - RC_{COM-MIN}$ | < 0.8μ S

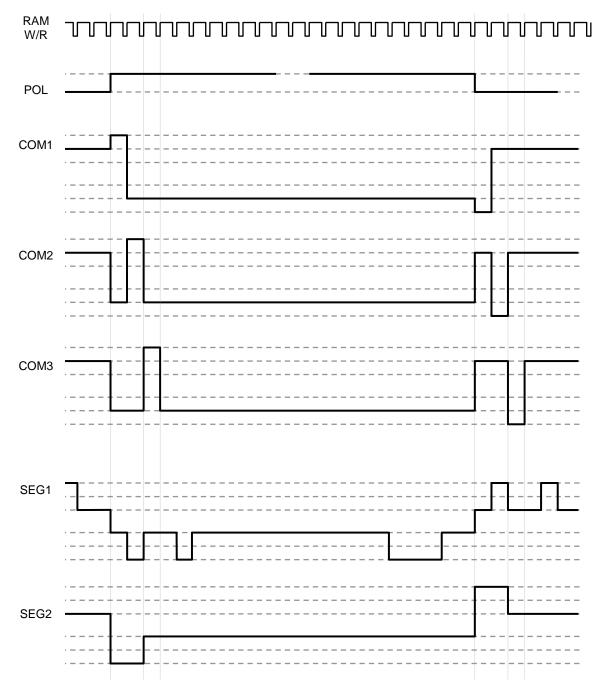


FIGURE 2: COM and SEG Driving Waveform

HOST INTERFACE

As summarized in the table below, UC1611s supports 2 parallel bus protocols, 8080 and 6800 (in 16-bit, 8-bit, or 4-bit bus width), and 3 serial bus protocols (4-wire, 3-sire, and 2-wire).

Designers can either use parallel bus to achieve high data transfer rate, or use serial bus to create compact LCD modules.

						Bus Type				
				Par	allel				Serial	
			8080			6800		S8	S9	I ² C
	Width	16-bit	8-bit	4-bit	16-bit	8-bit	4-bit	4-wire	3-wire	2-wire
	Access				F	Read/Write)			
	BM[1:0]	00	10	10	01	11	11	10	11	11
S	D[15, 13]	Data	00	01	Data	00	01	10	10	11
Pins	CS[1:0]				Chip S	Select				A[3:2]
Data	CD			C	Control/Dat	а			-	_
& D	WR0		WR			R/W			0	
	WR1		RD			EN			0	
Control	D[14, 12:8]	Data	-	-	Data	_	_		_	
0	D[7:4]	Da	ata	-	Da	ıta	_		-	•
	D[3:0]	Da	ata	Data	Da	ıta	Data	D3=	SDA, D0=	SCK

 $^{^{\}star}$ Connect unused control pins and data bus pins to V_{DD} or V_{SS}

Table 3: Host interfaces Choices

PARALLEL INTERFACE

The timing relationship between UC1611s' internal control signals, RD and WR, and their associated bus actions are shown in the figure below.

The Display RAM Read Interface is implemented as a two-stage pipe-line. This architecture requires a dummy read cycle to be performed before the actual data can propagate through the pipe-line and be read from data port D[7:0], every time memory address is modified (in 16-bit, 8-bit, or 4-bit mode) by either Set CA, or Set PA command.

There is no pipeline in write interface of Display RAM. Data is transferred directly from bus buffer to internal RAM on the rising edges of write pulses.

16-BIT, 8-BIT & 4-BIT BUS OPERATION

UC1611s supports 16-bit, 8-bit, and 4-bit bus widths. The bus width is determined by pins BM[1:0] and {D15, D13}.

UC1611s SARM read/write is based on 8-bit.

8-bit bus operation exactly doubles the clock cycles of 16-bit bus operation, while 4-bit doubles the clock cycles of 8-bit, MSB followed by LSB, including the dummy read, which also requires two clock cycles. For 16-bit bus operation, SRAM will perform read/write twice successively to finish a complete Read/Write.

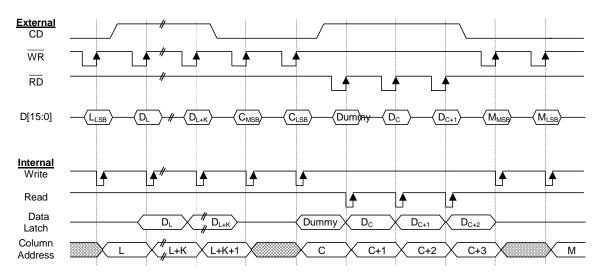


Figure 3.a: 16-bit Parallel Interface & Related Internal Signals

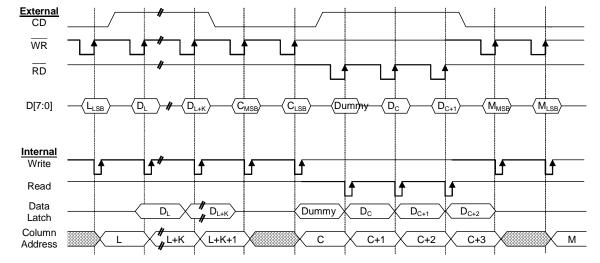


FIGURE 3.b: 8-bit Parallel Interface & Related Internal Signals

SERIAL INTERFACE

UC1611s supports 3 serial modes, 4-wire SPI mode (S8), 3-wire SPI mode (S9), and 2-wire SPI mode (I²C). Bus interface mode is determined by the wiring of the BM[1:0] and D7. See configuration table in the beginning of this section for more detail.

4-WIRE SERIAL INTERFACE (S8)

Pins CS[1:0] are used for chip select and bus cycle reset. Pin CD is used to determine the content of the data been transferred. During each write cycle, 8 bits of data, MSB first, are latched on eight rising SCK edges into an 8-bit data holder.

If CD=0, the data byte will be decoded as command. If CD=1, this 8-bit will be treated as data and transferred to proper address in the Display Data RAM on the rising edge of the last SCK pulse. Pin CD is examined when SCK is pulled low for the LSB (D0) of each token.

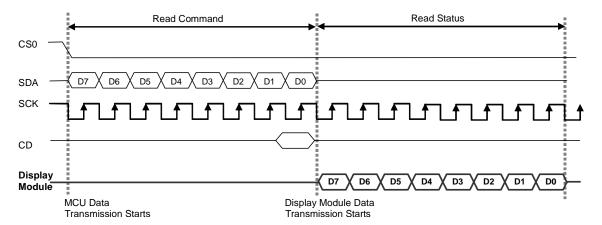


FIGURE 4.a: 4-wire Serial Interface (S8) - Read

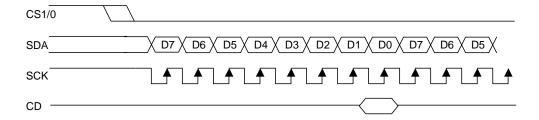


FIGURE 4.b: 4-wire Serial Interface (S8) – Write

3-WIER SERIAL INTERFACE (S9)

Pins CS[1:0] are used for chip select and bus cycle reset. On each write cycle, the first bit is CD, which determines the content of the following 8 bits of data, MSB first. These 8 command or data bits are latched on rising SCK edges into an 8-bit data holder.

If CD=0, the data byte will be decoded as command.

If CD=1, this 8-bit will be treated as data and transferred to proper address in the Display Data RAM at the rising edge of the last SCK pulse. By sending CD information explicitly in the bit stream, control pin CD is not used, and should be connected to either V_{DD} or V_{SS} . The toggle of CS0 (or CS1) for each byte of data/command is recommended but optional.

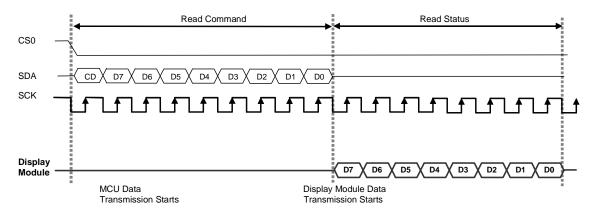


FIGURE 5.a: 3-wire Serial Interface (S9) - Read

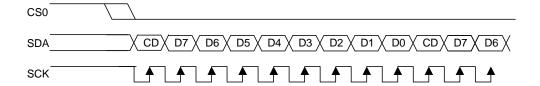
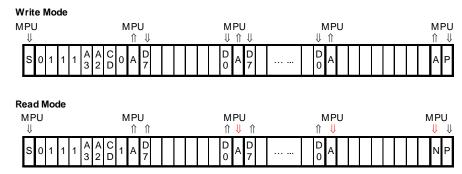


FIGURE 5.b: 3-wire Serial Interface (S9)

I²C (2-WIRE) INTERFACE



When BM[1:0] is set to "LH" and D[7:6] is set to "HH", UC1611s is configured as an I²C bus signaling protocol compliant slave device. Please refer to I²C standard for details of the bus signaling protocol, and AC Characteristic section for timing parameters of UltraChip implementation.

In this mode, pins CS[1:0] become A[3:2] and are used to configure UC1611s' device address. Proper wiring to $V_{\rm DD}$ or $V_{\rm SS}$ is required for the IC to operate properly for I²C mode.

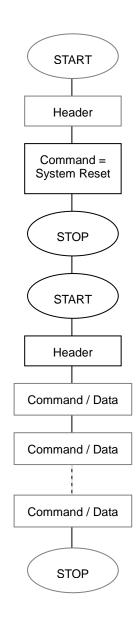
Each UC1611s I²C interface sequence starts with a "S" (Start) from the bus master, followed by a sequence header, containing a device address, the mode of transfer (CD, 0:Control, 1:Data), and the direction of the transfer (RW, 0:Write, 1:Read).

Since both WR and CD are expressed explicitly in the header byte, the control pins WR[1:0] and CD are not used in I^2C mode and should be connected to V_{SS} . The direction (read or write) and content type (command or data) of the data bytes following each header byte are fixed for the sequence. To change the direction ($R\Leftrightarrow W$) or the content type ($C\Leftrightarrow D$), start a new sequence with a START (S) flag, followed by a new header.

After receiving the header, the UC1611s will send out a "A" (Acknowledge signal). Then, depends on the setting of the header, the transmitting device (either the bus master or UC1611s) will start placing data bits on SDA, MSB to LSB, and the sequence will repeat until a STOP signal (P, in WRITE mode), or an N (Not Acknowledged, in READ mode) is sent by the bus master.

When using I²C serial mode, if command System Reset is to be written, the writing sequence must be finished (STOP) before succeeding data or commands start. The flow chart on the right shows a writing sequence with a "System Reset" command.

Note that, for data read (CD=1), the first byte of data transmitted will be dummy.



High-Voltage Mixed-Signal IC

HOST INTERFACE REFERENCE CIRCUIT

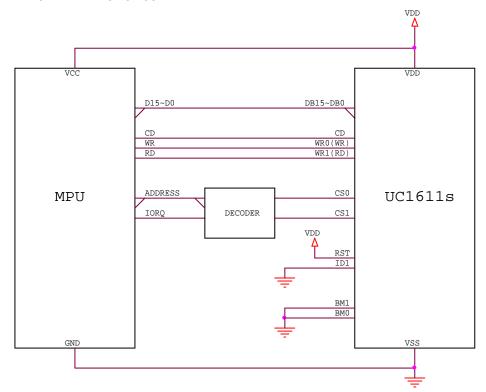


FIGURE 6: 8080/16-bit parallel mode reference circuit

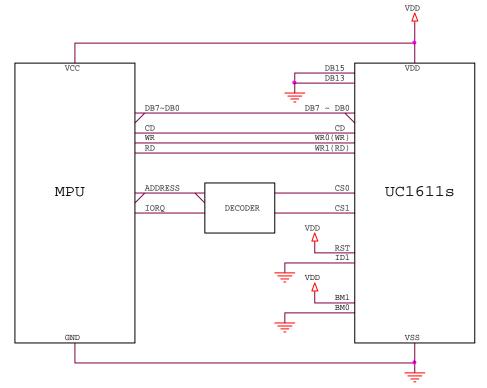
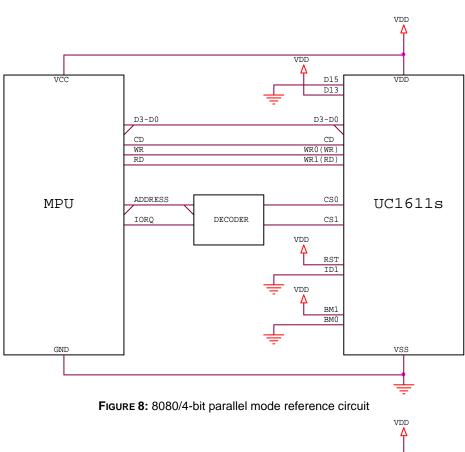


FIGURE 7: 8080/8-bit parallel mode reference circuit



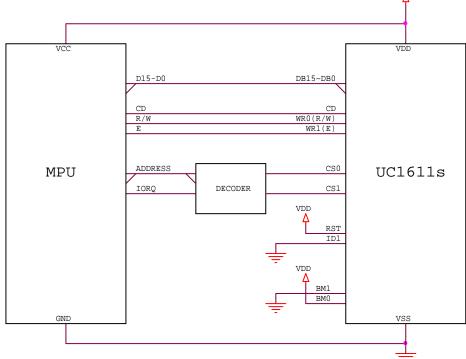


FIGURE 9: 6800/16-bit parallel mode reference circuit

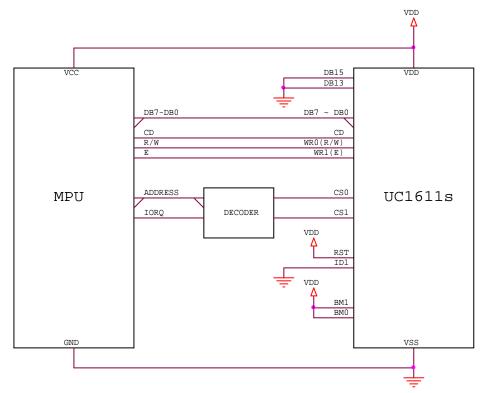


FIGURE 10: 6800/8-bit parallel mode reference circuit

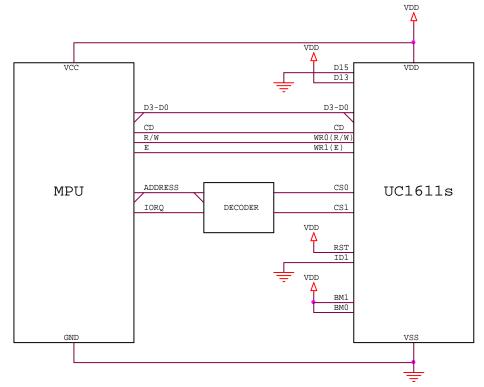


FIGURE 11: 6800/4-bit parallel mode reference circuit

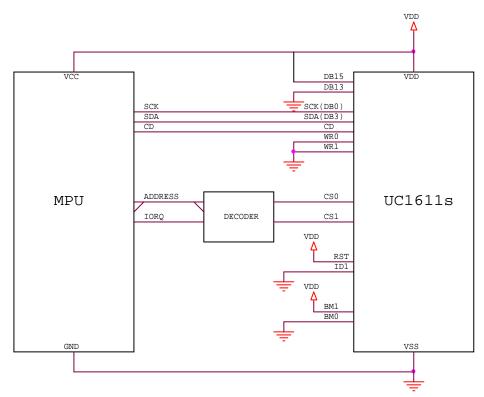


FIGURE 12: 4-Wire SPI (S8) serial mode reference circuit

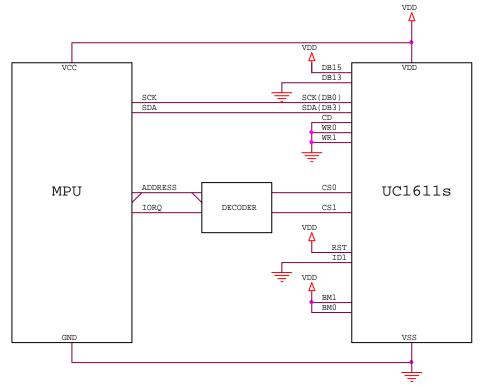


FIGURE 13: 3-Wire SPI (S9) serial mode reference circuit

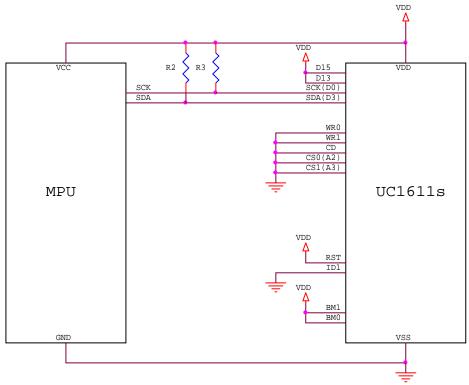


FIGURE 14: 2-Wire SPI (I²C) serial mode reference circuit

Note:

- 1. RST pin is optional. When RST pin is not used, connect the pin to V_{DD} .
- 2. When using I²C serial mode, CS1/0 are user configurable and affect A[3:2] of device address.
- 3. R1, R2: $2k \sim 10k \Omega$. Use lower resistor for bus speed up to 3.6MHz; while use higher resistor for lower power.

DISPLAY DATA RAM

DATA ORGANIZATION

The display data is 4-bit per pixel and stored in a dual port SRAM. The SRAM is organized as 160x 256x4.

After setting CA and PA, the next data write cycle will store the data for the specified pixel to the proper memory location.

Please refer to the map in the following page for the relation between the COM, SEG, SRAM, and various memory control registers.

DISPLAY DATA RAM ACCESS

The Display RAM is a special purpose dual port RAM that allows asynchronous access to both its column and row data. Thus, RAM can be independently accessed both for Host Interface and for display operations.

DISPLAY DATA RAM ADDRESSING

A Host Interface (HI) memory access operation starts with specifying Page Address (PA) and Column Address (CA) by issuing Set Page Address and Set Column Address commands.

If wrap-around (WA, AC[0]) is OFF (0), CA will stop incrementing after reaching the end of page (MC), and system programmers need to set the values of PA and CA explicitly.

If WA is ON (1), when CA reaches end of page, CA will be reset to 0 and PA will increment or decrement, depending on the setting of Page Increment Direction (PID, AC[2]). When PA reaches the boundary of RAM (i.e. PA = 0 or 79), PA will be wrapped around to the other end of RAM and continue.

MX IMPLEMENTATION

Column Mirroring (MX) is implemented by selecting either (CA) or (255–CA) as the RAM column address. Changing MX affects the data written to the RAM.

Since MX has no effect of the data already stored in RAM, changing MX does not have immediate effect on the displayed pattern. To refresh the display, refresh the data stored in RAM after setting MX.

RAM ADDRESS GENERATION

The mapping of the data store in the display SRAM and the scanning electrodes can be obtained by combining the fixed COM scanning sequence and the following RAM address generation formula.

When FL=0, during the display operation, the RAM line address generation can be mathematically represented as following:

For the 1st line period of each field *Line* = *SL*Otherwise *Line* = Mod (*Line* + 1, 160)

Where Mod is the modular operator, and *Line* is the bit slice line address of RAM to be outputted to SEG drivers. Line 0 corresponds to the first bit-slice of data in RAM.

The above *Line* generation formula produces the "loop around" effect as it effectively resets *Line* to 0 when *Line+1* reaches *160*. Effects such as page scrolling and page swapping can be emulated by changing SL dynamically.

MY IMPLEMENTATION

Row Mirroring (MY) is implemented by reversing the mapping order between COM electrodes and RAM, i.e. the mathematical address generation formula becomes:

For the 1st line period of each field

Line = Mod(SL + MUX - 1, 160)

where MUX is the Mux rate

Otherwise

Line = Mod(Line - 1, 160)

Visually, the effect of MY is equivalent to flipping the display upside down. The data stored in display RAM is not affected by MY.



WINDOW PROGRAM

High-Voltage Mixed-Signal IC

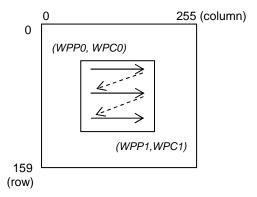
Window program is designed for data write in a specified window range of SRAM address. The procedure should start with window boundary registers setting (WPP0, WPP1, WPC0 and WPC1) and then enable AC[3]. After AC[3] is set, data can be written to SRAM within the window address range which is specified by (WPP0, WPC0) and (WPP1, WPC1). AC[3] should be cleared after any modification of window boundary registers and then set again in order to initialize another window program.

The data write direction will be determined by AC[2:0] and MX settings. When AC[0]=1, the data write can be consecutive within the range of the specified window. AC[1] will control the data write in either column or row direction. AC[2] will result the data write starting either from row WPP0 or WPP1. MX is for the initial column address either from WPC0 to WPC1 or from (MC-WPC0 to MC-WPC1).

Example1:

AC[2:0] = 001, MX=0

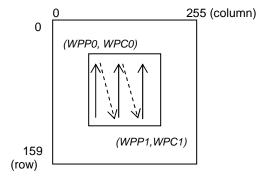
(PA auto INCREASING, COLUMN increasing first, auto wrap around, Mirror-X OFF)



Example 2:

AC[2:0] = 111, MX = 0

(PA auto DESCREASING, PAGE increasing first, auto wrap around, Mirror-X OFF)



MSF	Line										RAM							M	′=0	M	′=1
0 1	Adderss										KAW							SL=0	SL=16	SL=0	SL=16
D3/0 D7/4	00H	I																COM1	COM145	COM160	COM16
D7/4 D3/0	01H										Page 0							COM2	COM146	COM159	COM15
D3/0 D7/4	02H										D4							COM3	COM147	COM158	COM14
D7/4 D3/0	03H										Page 1							COM4	COM148	COM157	COM13
D3/0 D7/4	04H										Page 2							COM5	COM149	COM156	COM12
D7/4 D3/0	05H										rage z							COM6	COM150	COM155	COM11
D3/0 D7/4	06H										Page 3							COM7	COM151	COM154	COM10
D7/4 D3/0	07H										r age o							COM8	COM152	COM153	COM9
D3/0 D7/4	08H										Page 4							COM9	COM153	COM152	COM8
D7/4 D3/0	09H																	COM10	COM154	COM151	COM7
D3/0 D7/4	0AH									Ш	Page 5	\vdash						COM11	COM155	COM150	COM6
D7/4 D3/0	0BH											₩						COM12	COM156	COM149	COM5
D3/0 D7/4	0CH										Page 6	\vdash						COM13	COM157	COM148	COM4
D7/4 D3/0 D3/0 D7/4	0DH 0EH						Н					┢						COM14 COM15	COM158 COM159	COM147 COM146	COM3 COM2
D7/4 D3/0	0FH										Page 7							COM16	COM159	COM146 COM145	COM1
D3/0 D7/4	10H											H						COM17	COM1	COM144	COM160
D7/4 D3/0	11H										Page 8							COM17	COM2	COM144 COM143	COM159
D3/0 D7/4	12H											\vdash						COM19	COM3	COM142	COM158
D7/4 D3/0	13H			Т	Т		Т	\vdash		Н	Page 9	Т			Н			COM20	COM4	COM141	COM157
D3/0 D7/4	14H										De #= 40	H						COM21	COM5	COM140	COM156
D7/4 D3/0	15H				T		T			П	Page 10	П						COM22	COM6	COM139	COM155
D3/0 D7/4	16H										Dogs 44	T						COM23	COM7	COM138	COM154
D7/4 D3/0	17H										Page 11	П						COM24	COM8	COM137	COM153
D3/0 D7/4	18H										Page 12							COM25	COM9	COM136	COM152
D7/4 D3/0	19H										rage 12							COM26	COM10	COM135	COM151
D3/0 D7/4	1AH										Page 13							COM27	COM11	COM134	COM150
D7/4 D3/0	1BH										1 age 13							COM28	COM12	COM133	COM149
D3/0 D7/4	1CH										Page 14							COM29	COM13	COM132	COM148
D7/4 D3/0	1DH																	COM30	COM14	COM131	COM147
D3/0 D7/4	1EH									Ш	Page 15	\vdash						COM31	COM15	COM130	COM146
D7/4 D3/0	1FH											┢						COM32	COM16	COM129	COM145
D3/0 D7/4	8CH									Ш	Page 70	<u> </u>						COM141	COM125	COM20	COM36
D7/4 D3/0	8DH									H		┢						COM142	COM126	COM19	COM35
D3/0 D7/4	8EH									Н	Page 71	\vdash						COM143	COM127	COM18	COM34 COM33
D7/4 D3/0 D3/0 D7/4	8FH 90H											\vdash						COM144 COM145	COM128 COM129	COM17 COM16	COM32
D7/4 D3/0	90H 91H									Н	Page 72							COM145	COM129	COM15	COM31
D3/0 D7/4	92H											\vdash						COM147	COM131	COM14	COM30
D7/4 D3/0	93H			Н	\vdash	\vdash	Н	\vdash		Н	Page 73	H			\vdash			COM147	COM131	COM14	COM29
D3/0 D7/4	94H									П	D	T						COM149	COM133	COM12	COM28
D7/4 D3/0	95H										Page 74							COM150	COM134	COM11	COM27
D3/0 D7/4	96H										Page 75							COM151	COM135	COM10	COM26
D7/4 D3/0	97H										raye / ɔ							COM152	COM136	COM9	COM25
D3/0 D7/4	98H										Page 76							COM153	COM137	COM8	COM24
D7/4 D3/0	99H			Щ						Ш	1 age 10	匚						COM154	COM138	COM7	COM23
D3/0 D7/4					_	_				Ш	Page 77	$ldsymbol{le}}}}}}$						COM155	COM139	COM6	COM22
D7/4 D3/0				Щ	<u> </u>	_	lacksquare	<u> </u>		Щ		┡			<u> </u>			COM156	COM140	COM5	COM21
D3/0 D7/4	9CH		<u> </u>		_	_	H	<u> </u>	<u> </u>	Н	Page 78	\vdash			<u> </u>			COM157	COM141	COM4	COM20
D7/4 D3/0				H	—	-	H	-		Н		H			<u> </u>			COM158	COM142	COM3	COM19
D3/0 D7/4 D7/4 D3/0	9EH 9FH		_	H	\vdash	\vdash	\vdash	<u> </u>	-	Н	Page 79	\vdash			\vdash			COM159 COM160	COM143 COM144	COM2 COM1	COM18 COM17
D1/4 D3/0	9FH											23	23	4	īζ	9	1	COM160	CON 144	COWIT	COWIT
	~	0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG	SEG7	SEG8		SEG252	SEG253	SEG254	SEG255	SEG256					
	W	-	SEG256	SEG255	SEG254	SEG253	SEG252	SEG251	SEG250	SEG249		SEG5	SEG4	SEG3	SEG2	SEG1					
				<u> </u>	<u> </u>	<u> </u>						1					ı				

When DC[5:3] = 0xxb:

Example for memory mapping:

let MX = 0, MY = 0, SL = 0, MSF = 0, according to the data shown in the above table:

⇒ Page 0 SEG 1 : (D[7:0]) 0000 1111 b
⇒ Page 0 SEG 2 : (D[7:0]) 1111 0000 b



High-Voltage Mixed-Signal IC

M	SF.	Line	1									RAM						MY	′-0	MY	/_1
0	5F 1	Adderss										r Alvi						SL=0	SL=16	SL=0	SL=16
D0	D4	00H	1					Π			П		1					COM1	COM145	COM160	COM16
D1	D5	01H	1															COM2	COM146	COM159	COM15
D2	D6	02H	Ī															COM3	COM147	COM158	COM14
D3	D7	03H	1									Bogo 0						COM4	COM148	COM157	COM13
D4	D0	04H										Page 0						COM5	COM149	COM156	COM12
D5	D1	05H																COM6	COM150	COM155	COM11
D6	D2	06H																COM7	COM151	COM154	COM10
D7	D3	07H																COM8	COM152	COM153	COM9
D0	D4	08H																COM9	COM153	COM152	COM8
D1	D5	09H	4		-						Ш		\vdash			_		COM10	COM154	COM151	COM7
D2	D6	0AH	-															COM11	COM155	COM150	COM6
D3 D4	D7	0BH 0CH	-		-						H	Page 1	\vdash					COM12	COM156	COM149	COM5
D5	D0 D1	0DH	-			H							\vdash					COM13 COM14	COM157 COM158	COM148 COM147	COM4 COM3
D6	D2	0EH	1										\vdash					COM14 COM15	COM159	COM147 COM146	COM2
D7	D3	0FH	1								Н					H		COM16	COM160	COM145	COM1
D0	D4	10H	1										1					COM17	COM1	COM144	COM160
D1	D5	11H	1			Н										Н		COM18	COM2	COM143	COM159
D2	D6	12H	1		t	П		T			П		\vdash					COM19	COM3	COM142	COM158
D3	D7	13H	1									Dom 2						COM20	COM4	COM141	COM157
D4	D0	14H	1									Page 2						COM21	COM5	COM140	COM156
D5	D1	15H																COM22	COM6	COM139	COM155
D6	D2	16H]															COM23	COM7	COM138	COM154
D7	D3	17H	1			$ldsymbol{ldsymbol{ldsymbol{eta}}}$										$ldsymbol{ldsymbol{ldsymbol{eta}}}$		COM24	COM8	COM137	COM153
D0	D4	18H	1															COM25	COM9	COM136	COM152
D1	D5	19H																COM26	COM10	COM135	COM151
D2	D6	1AH	4															COM27	COM11	COM134	COM150
D3	D7	1BH	4									Page 3	\vdash					COM28	COM12	COM133	COM149
D4	D0	1CH	-										\vdash				-	COM29	COM13	COM132	COM148
D5 D6	D1 D2	1DH 1EH	-										\vdash					COM30 COM31	COM14 COM15	COM131 COM130	COM147 COM146
D7	D3	1FH	1								H		\vdash					COM32	COM15	COM130 COM129	COM146 COM145
D0	D4	90H	1															COM145	COM129	COM16	COM32
D1	D5	91H]		L													COM146	COM130	COM15	COM31
D2	D6	92H]		L													COM147	COM131	COM14	COM30
D3	D7	93H										Page 18						COM148	COM132	COM13	COM29
D4	D0	94H]									1 age 10						COM149	COM133	COM12	COM28
D5	D1	95H	1								Ш		\square			$oxed{\Box}$	Ш	COM150	COM134	COM11	COM27
D6	D2	96H	1		<u> </u>			_			Ш		\vdash			_		COM151	COM135	COM10	COM26
D7	D3	97H	1	_	<u> </u>	L		_	_		Щ		\perp	_	_	_	Ш	COM152	COM136	COM9	COM25
D0	D4	98H	-	<u> </u>	<u> </u>	H		<u> </u>	<u> </u>		Ш		\vdash		_	<u> </u>	<u> </u>	COM153	COM137	COM8	COM24
D1	D5	99H	-	\vdash	┢	H		\vdash	-		Н		\vdash	<u> </u>	-	\vdash	\vdash	COM154	COM138	COM7	COM23
D2	D6	9AH	-	\vdash	┢	H	<u> </u>	\vdash	\vdash	_	Н		\vdash	<u> </u>	_	\vdash	\vdash	COM155	COM139	COM6	COM22
D3	D7	9BH	1	\vdash	┢	H	\vdash	\vdash	\vdash	\vdash	Н	Page 19	\vdash	_	\vdash	\vdash	\vdash	COM156 COM157	COM140 COM141	COM5	COM21
D4 D5	D0 D1	9CH 9DH	1	\vdash	\vdash	H	 	\vdash	\vdash	<u> </u>	H		\vdash	<u> </u>	 	\vdash	\vdash	COM157 COM158	COM141 COM142	COM4 COM3	COM20 COM19
D6	D2	9EH	1								Н		\vdash				\vdash	COM158	COM142	COM2	COM19 COM18
D7	D3	9FH	1	\vdash	\vdash	Н		\vdash	\vdash		Н		\vdash		\vdash	\vdash		COM160	COM143	COM2	COM17
		XX	0 1	SEG256 SEG1	SEG255 SEG2	SEG254 SEG3	SEG253 SEG4	SEG252 SEG5	SEC251 SEG6	SEG250 SEG7	SEG249 SEG8		SEG5 SEG252	SEG4 SEG253	SEG3 SEG254	SEG2 SEG255	SEG1 SEG256				
				SE	SE	SE	SE	SE	SE	SE(SE		SE	SE	SE	SE	SE				

When DC[5:3]=100b:

Example for memory mapping:

Let MX = 0, MY = 0, SL = 0, MSF = 0, according to the data shown in the above table:

⇒ Page 0 SEG 1 : (D[7:0]) 1000 1111 b Page 0 SEG 2: (D[7:0]) 0100 1100 b

RESET & POWER MANAGEMENT

Types of Reset

UC1611s has two different types of Reset: Power-ON-Reset and System-Reset.

Power-ON-Reset is performed right after V_{DD} is connected to power. Power-On-Reset will first wait for about 5~10mS, depending on the time required for V_{DD} to stabilize, and then trigger the System Reset.

System Reset can also be activated by software command or by connecting RST pin to ground.

In the following discussions, Reset means System Reset.

RESET STATUS

When UC1611s enters RESET sequence:

- Operation mode will be "Reset"
- All control registers are reset to default values.
 Refer to Control Registers for details of their default values.

OPERATION MODES

UC1611s has 3 operating modes (OM): Reset, Normal, Sleep.

Mode	Reset	Sleep	Normal
ОМ	00	10	11
Host Interface	Active	Active	Active
Clock	OFF	OFF	ON
LCD Drivers	OFF	OFF	ON
Charge Pump	OFF	OFF	ON
Draining Circuit	ON	ON	OFF

Table 4: Operating Modes

CHANGING OPERATION MODE

In addition to Power-ON-Reset, two commands will initiate OM transitions:

Set Display Enable, and System Reset.

When DC[2] is modified by Set Display Enable, OM will be updated automatically. There is no other action required to enter Sleep mode.

OM changes are synchronized with the edges of the IC's internal clock. To ensure consistent system states, wait at least $10\mu S$ after Set Display Enable or System Reset command.

Action	Mode	OM
Reset command RST_ pin pulled "L" Power-ON-Reset	Reset	00
Set Driver Enable to "0"	Sleep	10
Set Driver Enable to "1"	Normal	11

Table 5: OM changes

Both Reset mode and Sleep mode drain the charges stored in the external capacitors C_{B0} , C_{B1} , and C_L . When entering Reset mode or Sleep mode, the display drivers will be disabled.

The difference between Sleep mode and Reset mode is that, Reset mode clears all control registers and restores them to default values, while Sleep mode retains all the control registers values set by the user.

It is recommended to use Sleep Mode for Display OFF operations as the IC consumes very little energy in Sleep mode (typically under $1\mu A$).

EXITING SLEEP MODE

UC1611s contains internal logic to check whether V_{LCD} are ready before releasing COM and SEG drivers from their idle states. When exiting Sleep or Reset Mode, COM and SEG drivers will not be activated until UC1611s' internal voltage sources are restored to their proper values.



POWER-UP SEQUENCE

High-Voltage Mixed-Signal IC

UC1611s power-up sequence is simplified by built-in "Power Ready" flags and the automatic invocation of System-Reset command after Power-ON-Reset.

System programmers are only required to wait 150 mS before the CPU starting to issue commands to UC1611s. No additional time sequences are required between enabling the charge pump, turning on the display drivers, writing to RAM or any other commands.

There's no delay needed while turning on V_{DD} and V_{DD2/3}, and either one can be turned on first.

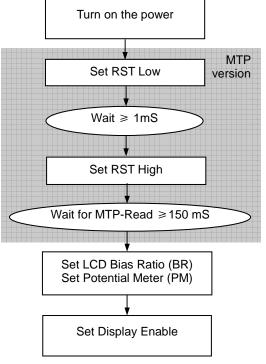


FIGURE 15: Reference Power-Up Sequence

POWER-DOWN SEQUENCE

To prevent the charge stored in capacitor C_L from causing abnormal residue horizontal line on display when V_{DD} is switched off, use Reset mode to enable the built-in charge draining circuit to discharge the external capacitor.

When internal V_{LCD} is not used, UC1611s will NOT drain V_{LCD} during RESET. System designers need to make sure external V_{LCD} source is properly drained off before turning off V_{DD}.

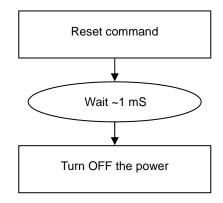


FIGURE 16: Reference Power-Down Sequence

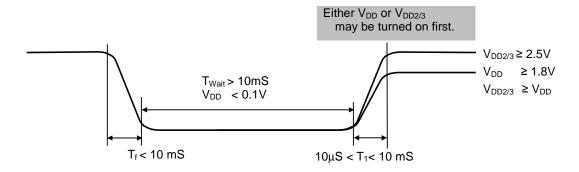


Figure 17: Delay allowance between V_{DD} and V_{DD2/3}

MULTI-TIME PROGRAM NV MEMORY

OVERVIEW

MTP feature is available for UC1611s such that LCM maker can record an PM offset value in non-volatile memory cells, which can then be used to adjust the effective V_{LCD} value, in order to achieve high level of consistency for LCM contrast across all shipments.

To accomplish this purpose, three operations are supported by UC1611s:

MTP-Erase, MTP-Program, MTP-Read.

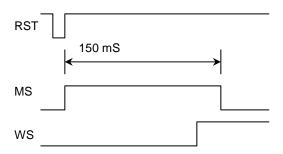
MTP-Program requires an external power source supplied to TST4 pin. MTP allows to program at least 10 times and should be performed only by the LCM makers.

MTP-Read is facilitated by the internal DC-DC converter built-in on UC1611s, no external power source is required, and it is performed automatically after hardware RESET (power-ON or pin RESET).

OPERATION FOR THE SYSTEM USERS

For the MTP version of UC1611s, the content of the NV memory will be read automatically after the power-on and hardware pin RESET. There is no user intervention or external power source required. When set up properly, the V_{LCD} will be fine tuned to achieve high level of consistency for the LCM contrast.

The MTP-READ is a relatively slow process and the time required can vary quite a bit. For a successful MTP-READ operation, the MS and WS bits in the *Read Status* commands will exhibit the following waveforms.



As illustrated above, the {MS, WS} will go through a $\{0,0\} \Rightarrow \{1,0\} \Rightarrow \{1,1\} \Rightarrow \{0,1\}$ transition. When the {MS, WS}= $\{0,1\}$ state is reached, it means the LCM is ready to be turned on.

During the MTP-READ process, it is actually safe to issue commands or perform data write to the LCM. The only thing that is blocked is the LSB of the Set Display Enable command, which results in the DC[2] being effectively locked at "0" during this auto-MTP-READ process.

Although user can use *Read Status* command in a polling loop to make sure {MS,WS}={0,1} before proceeding with the Set Display Enable command, however, it may be simpler to just issue the Set Display Enable command every 0.2~2 second, repeatedly, together with other LCM optimization settings, such as BR, CEN, TC, etc.

The above "Periodical re-initializing" approach is also an effective safeguard against accidental display off events such as

- ESD strikes
- Mechanical shocks causing LCM connector to malfunction temporarily

HARDWARE VS. SOFTWARE RESET

The auto-MTP-READ is only performed for hardware RESET (power-ON and RST pin), but not for software *RESET* command. This enables the ICs to turn on display faster without the delay caused by MTP-READ.

It is recommended to use software *RESET* for normal operation control purpose and hardware RESET only during the event of power up and power down.

OPERATION FOR THE LCM MAKERS



MTP OPERATION FOR LCM MAKERS

1. High voltage supply and timer setting

In MTP Program operation, two different high voltages are needed. In chip design, one high voltage is generated by internal charge pump (V_{LCD}), the other high voltage must be input from TST4 by external voltage source.

 V_{LCD} value is controlled by register MTP1 and MTP2. The default values of these two registers are appropriate for most applications.

External TST4 power source is required for MTP Program operation. MTP Programming speed depends on the TST4 voltage. Considering the ITO trace resistance in COG modules, it is recommended to program the MTP cells one at a time, so that the required 10V at TST4 can be maintained with proper consistency.

No external power source is required for MTP Erase and Read operation. For these MTP operation, TST4 should be open, or connected to V_{DD3} .

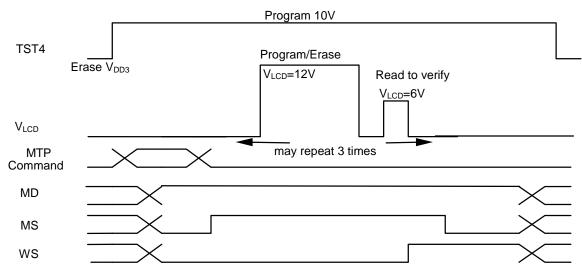
Operation	V _{LCD}	TST4 (external input)
Program	MTP2 : 15h (12V)	10V (1mA per bit)
Erase	MTP2 : 15h (12V)	Floating or V _{DD3}
Read	MTP1:69h (6V)	Floating or V _{DD3}

Note:

- 1. Do Erase before Program. Program one bit at a time.
- 2. When doing MTP Program or Erase, it's required to use $V_{DD2/3} \ge 3.0V$.

2. Read MTP status bits

With normal Get Status method (CD=0,W/R=1), MTP operation status can be monitored in the real time. There are 3 status bits (WS, MD, MS) in status register. MTP control circuit will read to verify if the operation (program, erase) success or not. If the operation succeeded, and current operation will be ended with WS=1. If it failed, last operation will be automatically retried two more times. If it fails 3 times, WS will be set to 0 and the operation is aborted. MD is MTP ID, which is either 1 for MTP IC. No transition.



MTP status bits, TST4 & V_{LCD} Waveform

MTP CELL VALUE USAGE

There are 6 MTP cell bits.

PMO[5:0]: V_{LCD} Trim

When PMO[5]=1: PM with trim = PM - PMO[4:0] When PMO[5]=0: PM with trim = PM + PMO[4:0]

MTP COMMAND SEQUENCE SAMPLE CODES

The following tables are examples of command sequence for MTP Program and Erase operations. These are only to demonstrate some "typical, generic" scenarios. Designers are encouraged to study related sections of the datasheet and find out what the best parameters and control sequences are for their specific design needs.

MTP operations (Erase, Program, Read) and Set Display ON is mutual exclusive. There is no harm done to the IC or the LCM if this is violated. However, the violating commands will be ignored.

Type Required: These items are required

 \underline{C} ustomized: These items are not necessary if customer parameters are the same as default \underline{A} dvanced: We recommend new users to skip these commands and use default values.

Optional: These commands depend on what users want to do.

C/D The type of the interface cycle. It can be either Command (0) or Data (1)

W/R The direction of dataflow of the cycle. It can be either Write (0) or Read (1).

(1) MTP Program Sample Code

Туре	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Chip Action	Comments
R	-	-	-	-	_	-	-	-	-	-	Set RST pin Low	Wait 1mS after RST is Low
R	-	-	-	-	_	-	-	-	-	-	Set RST pin High	
R	-	-	-	-	_	-	-	-	-	-	Automatic Power-ON Reset.	Wait ~150mS
R	0	0	1	0	1	0	0	0	1	1	Set Line Rate	Set LC[5:4]=11b
R	0	0	1	1	1	1	0	1	0	0	Set V _{MTP1} Potentiometer	Set MTP V _{LCD}
R	0	0	0	1	1	0	1	0	0	1		MTP1: 69h(6V)
R	0	0	1	1	1	1	0	1	0	1	Set V _{MTP2} Potentiometer	Set MTP V _{LCD}
R	0	0	0	0	1	0	0	1	0	1		MTP2: 25h(12V)
R	0	0	1	1	1	1	0	1	1	0	Set MTP Write Timer	Set MTP Timer
R	0	0	0	0	1	0	0	1	0	1		MTP3:25h(100mS)
R	0	0	1	1	1	1	0	1	1	1	Set MTP Read Timer	Set MTP Timer
R	0	0	0	0	0	0	0	1	0	1		MTP4:05h(10mS)
R	0	0	1	0	1	1	1	0	0	1	Set MTP Write Mask	Set MTP Bit Mask
С	0	0	0	0	0	0	0	0	0	1	МТРМ	Ex: To program PMO[5:0], set MTPM *
R	-	-	ı	1	-	ı	ı	ı	ı	1		Apply TST4 voltage Program: 10V
R	0	0	1	0	1	1	1	0	0	0	Set MTP Control	Set MTPC[3]=1
R	0	0	-	-	0	0	1	0	1	1		Set MTPC[2:0]=011
R	0	1	-	-	-	-	-	ws	-	MS	Get Status & PM	Check MTP Status until MS=0 and WS=1
R												Remove TST4 voltage
R											V _{DD} =0V	Power OFF

^{*} It is recommended that users program one bit at a time.

(2) MTP Erase Sample Code

Туре	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Chip action	Comments
R	_	-	-	-	-	-	-	-	_	-	Set RST pin Low	Wait 1mS after RST is Low
R	-	-	-	-	-	-	-	-	_	-	Set RST pin High	
R	_	-	-	-	-	-	-	-	_	-	Automatic Power-ON Reset.	Wait ~150mS
R	0	0	1	0	1	0	0	0	1	1	Set Line Rate	Set LC[5:4]=11b
R	0	0	1	1	1	1	0	1	0	0	Set V _{MTP1} Potentiometer	Set MTP V _{LCD}
R	0	0	0	1	1	0	1	0	0	1		MTP1: 69h(6V)
R	0	0	1	1	1	1	0	1	0	1	Set V _{MTP2} Potentiometer	Set MTP V _{LCD}
R	0	0	0	0	1	0	0	1	0	1		MTP2: 25h(12V)
R	0	0	1	1	1	1	0	1	1	0	Set MTP Write Timer	Set MTP Timer
R	0	0	0	0	1	0	0	1	0	1		MTP3:25h(100mS)
R	0	0	1	1	1	1	0	1	1	1	Set MTP Read Timer	Set MTP Timer
R	0	0	0	0	0	0	0	1	0	1		MTP4:05h(10mS)
R	0	0	1	0	1	1	1	0	0	1	Set MTP Write Mask	Set MTP Bit Mask
С	0	0	0	0	1	1	1	1	1	1	MTPM	Ex: To erase PMO[5:0] , set MTPM
R	0	0	1	0	1	1	1	0	0	0	Set MTP Control	Set MTPC[3]=1
R	0	0	-	1	0	0	1	0	1	0		Set MTPC[2:0]=010
R	0	1	-	-	-	-	-	ws	•	MS	Get Status & PM	Check MTP Status until MS=0 WS=1
R											V_{DD} = $0V$	Power OFF

^{*} It is recommended that users clear all the bits to be programmed.



SAMPLE COMMAND SEQUENCES

The following tables are examples of command sequence for power-up, power-down and display ON/OFF operations. These are only to demonstrate some "typical, generic" scenarios. Designers are encouraged to study related sections of the datasheet and find out what the best parameters and control sequences are for their specific design needs.

Type Required: These items are required

<u>C</u>ustomized: These items are not necessary, if customer parameters are the same as default <u>A</u>dvanced: We recommend new users to skip these commands and use default values.

Optional: These commands depend on what users want to do.

C/D The type of the interface cycle. It can be either Command (0) or Data (1) W/R The direction of data-flow of the cycle. It can be either Write (0) or Read (1).

Power-Up

Туре	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Chip action	Comments
R	_	ı	ı	ı	ı	-	ı	ı	ı	ı	Turn on V_{DD} and $V_{DD2/3}$	Wait until V_{DD} and $V_{DD2/3}$ are stable
R	_	ı	-	1	1	_	1	1	-	ı	Set RST pin Low	Wait 1mS after RST is Low
R	_	-	-	-	-	_	-	-	-	1	Set RST pin High	
R	_	-	-	1	-	_	-	-	-	1	Automatic Power-ON Reset.	Wait ~150mS
С	0	0	0	0	1	0	0	1	#	#	Set Temp. Compensation	Cotor I OD town at one siting
С	0	0	1	1	0	0	0	0	0	0	Sat I CD Manning Control	Set up LCD format specific parameters, MX, MY, etc.
С	0	0	0	0	0	0	#	#	#	#	Set LCD Mapping Control	parameters, wix, wir, etc.
Α	0	0	1	0	1	0	0	0	#	#	Set Line Rate	Fine tune for power, flicker, contrast, and shading.
С	0	0	1	1	1	0	1	0	#	#	Set LCD Bias Ratio	LCD apositio appreting
R	0	0	1 #	0 #	0 #	0 #	0 #	0 #	0 #	1 #	Set Gain and PM	LCD specific operating voltage setting
	1	0	#	#	#	#	#	#	#	#		
0		0	#	. #			#		#		Write display RAM	Set up display image
R	0	0	1	0	# 1	# 0	1	# 1	1	# 1	Set Display Enable	

Power-Down

Туре	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Chip action	Comments
R	0	0	1	1	1	0	0	0	1	0	System Reset	
R	-	_	-	ı	-	1	ı	-	ı	-	Draining capacitor	Wait ~1mS before V _{DD} OFF

DISPLAY-OFF

Туре	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Chip action	Comments
R	0	0	1	0	1	0	1	0	0	0	Set Display Disable	
0	1 1	0	# #	# · · #	Write display RAM	Set up display image. (Image update is optional. Data in the RAM is retained through the SLEEP state.)						
R	0	0	1	0	1	0	1	1	1	1	Set Display Enable	

ESD CONSIDERATION

UC1600 series products usually are provided in bare die format to customers. This makes the product
particularly sensitive to ESD damage during handling and manufacturing process. It is therefore highly
recommended that LCM makers strictly follow the "JESD 625-A Requirements for Handling
Electrostatic-Discharge-Sensitive (ESDS) Devices" when manufacturing LCM.

In particular, the following pins in UC1611s require special "ESD Sensitivity" consideration, please refer to Table below. According to UltraChip's Mass Production experience, the following ESD tolerance conditions has been shown be very stable and produce high yield in multiple customer sites. However, special care is still required during handling and manufacturing process to avoid unnecessary yield loss due to ESD damages.

Test M	Modo	Machin	e Mode	Human Body Mode			
iest iv	loue	V_{DD}	V _{SS}	V_{DD}	V _{SS}		
LCD D)river	200V	200V	2000V	2500V		
LCM Int	erface	300V	300V	3000V	3000V		
	TST1/2/4	300V	300V	3000V	3000V		
LCM HV pin/	CB pins	300V	300V	3000V	3000V		
Test pin	V _{LCDIN}	300V	300V	3000V	3000V		
V _{LCDOUT}		300V	300V	3000V	3000V		
PWR / GND		-	300V	-	3000V		

^{*} MM: Machine Mode

2. LCM design suggestions: To minimize potential ESD damages in assembly LCD modules(COG or COF) and modules test, please consider placing external components (C_{VLCD} , and C_{B0} , C_{B1}) in such a way that they will not be exposed to Machine Mode ESD zap path. For example, place C_{VLCD} and C_{B} capacitors on the internal side after folding FPC.



ABSOLUTE MAXIMUM RATINGS

In accordance with IEC134, note 1, 2 and 3.

Symbol	Parameter	Min.	Max.	Unit
V_{DD}	Logic Supply voltage	-0.3	+4.0	V
V_{DD2}	LCD Generator Supply voltage	-0.3	+4.0	V
V_{DD3}	Analog Circuit Supply voltage	-0.3	+4.0	V
$V_{DD2/3}$ - V_{DD}	Voltage difference between V _{DD} and V _{DD2/3}		2.0	V
V_{LCD}	LCD Generated voltage (-30°C ~ +80°C)	-0.3	+19.8	V
V_{IN}	Digital input voltage	-0.4	$V_{DD} + 0.5$	V
T _{OPR}	Operating temperature range	-30	+85	°C
T _{STR}	Storage temperature	-55	+125	°C

Note:

- V_{DD} is based on V_{SS} = 0V
 Stress above values listed may cause permanent damages to the device.

SPECIFICATIONS

DC CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V_{DD}	Supply for digital circuit		1.65	1.8~3.3	3.6	V
V _{DD2/3}	Supply for bias & pump		2.7	2.8~3.3	3.6	V
V_{LCD}	Charge pump output	$V_{DD2/3} \ge 2.4V, 25^{\circ}C$		17	17.5	V
V _D	LCD data voltage	$V_{DD2/3} \ge 2.4V, 25^{\circ}C$			1.69	V
V _{IL}	Input logic LOW				0.2V _{DD}	V
V _{IH}	Input logic HIGH		0.8V _{DD}			V
V _{OL}	Output logic LOW				$0.2V_{DD}$	V
V _{OH}	Output logic HIGH		0.8V _{DD}			V
I _{IL}	Input leakage current				1.5	μΑ
C _{IN}	Input capacitance			5	10	pF
C _{OUT}	Output capacitance			5	10	pF
R _{0(SEG)}	SEG output impedance	$V_{LCD} = 17V$		1.35	2.5	kΩ
R _{0(COM)}	COM output impedance	$V_{LCD} = 17V$		1.35	2.5	kΩ
f _{LINE}	Average Line rate	LC[5:4] = 10b	-10%	28	+10%	kHz

POWER CONSUMPTION

 $V_{DD} = 2.7 V$, Bias Ratio = 11, PM = 234,

Panel Loading (PC[1:0]) = 11 b, $C_L = 500 \text{ nF}$, MTP= 00 H, $V_{LCD} = 17.01 \text{ V},$ Line Rate = 10 b,

Mux Rate = 160, Bus mode = 6800, Temperature = 25 °C, $C_B = 5 \mu F$, All HV outputs are open circuit.

Display Pattern	Conditions	Typ. (μA)	Max. (μA)
All-OFF	Bus = idle	1656	2484
2-pixel checker	Bus = idle	2031	3046
	Bus = idle (standby current)		5



AC CHARACTERISTICS

High-Voltage Mixed-Signal IC

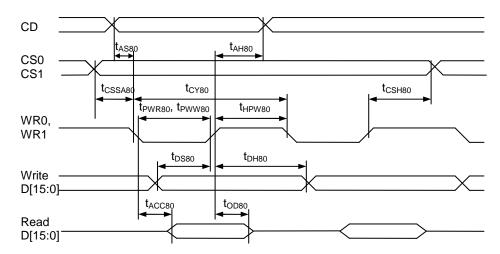


FIGURE 18: Parallel Bus Timing Characteristics (for 8080 MCU)

Symbol	Signal	Description		Condition	Min. (nS)	Max. (nS)
$(2.5V \leq V_{DD} <$	3.6V, Ta= −30	to +85°C)			(Read / Write)	
t _{AS80}	CD	Address setup time			0	-
t _{AH80}		Address hold time			0	
t _{CY80}		System cycle time	16-bit bus		440 / 360	_
			8-bit bus		180 / 160	
	14/D4 14/D0	Law Data and Mile	4-bit bus		130 / 100	
t _{PWR80}	WR1, WR0	Low Pulse width	16-bit bus 8-bit bus		205 / 165 75 / 65	_
t _{PWW80}			4-bit bus		75 / 65 50 / 35	
t	WR1, WR0	High pulse width	16-bit bus		205 / 165	_
t _{HPW80}	771(1, 771(0	I light palee width	8-bit bus		75 / 65	
			4-bit bus		50 / 35	
t _{DS80}	D15~D0	Data setup time			30	_
t _{DH80}		Data hold time			0	
t _{ACC80}		Read access time			_	60
t _{OD80}		Output disable time		$C_L = 100pF$	30	_
t _{SSA80}	CS1/CS0	Chip select setup time			0	
t _{CSH80}					0	
$(1.65V \leq V_D)$	_D < 2.5V, Ta= –3	30 to +85°C)			(Read / Write)	
t _{AS80}	CD	Address setup time			0	_
t _{AH80}		Address hold time			0	
t _{CY80}		System cycle time	16-bit bus		830 / 630	_
			8-bit bus		330 / 290	
			4-bit bus		230 / 170	
t _{PWR80}	WR1	Low Pulse width	16-bit bus		400 / 300	-
t _{PWW80}	WR0		8-bit bus		150 / 130	
	14/54 14/50		4-bit bus		100 / 70	
t _{HPW80}	WR1, WR0	High pulse width	16-bit bus		400 / 300	_
			8-bit bus		150 / 130	
	D15~D0	Data actus tima	4-bit bus		100 / 70 60	
t _{DS80}	טט~טוע	Data setup time Data hold time			0	_
t _{DH80}		Read access time				120
t _{ACC80}		Output disable time		$C_{L} = 100pF$	- 50	120
t _{OD80}	CS1/CS0	'			0	
t _{SSA80}	CS1/CS0	Chip select setup time			0	
t _{CSH80}					U	

Note: The rising time and the falling time are stipulated to be equal to or less than 15nS.

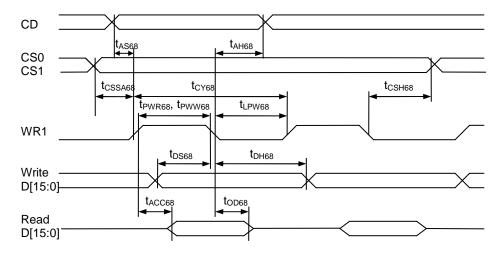


FIGURE 19: Parallel Bus Timing Characteristics (for 6800 MCU)

Symbol	Signal	Descriptio	n	Condition	Min. (nS)	Max. (nS)
$(2.5V \leq V_{DD} <$	< 3.6V, Ta= −30	to +85°C)			(Read / Write)	
t _{AS68} t _{AH68}	CD	Address setup time Address hold time			0 0	_
t _{CY68}		System cycle time	16-bit bus 8-bit bus 4-bit bus		440 / 360 180 / 160 130 / 100	-
t _{PWR68} t _{PWW68}	WR1, WR0	Low Pulse width	16-bit bus 8-bit bus 4-bit bus		205 / 165 75 / 65 50 / 35	-
t _{LPW68}	WR1, WR0	High Pulse width	16-bit bus 8-bit bus 4-bit bus		205 / 165 75 / 65 50 / 35	-
t _{DS68} t _{DH68}	D15~D0	Data setup time Data hold time			30 0	_
t _{ACC68} t _{OD68}		Read access time Output disable time		$C_L = 100pF$	- 30	60 -
t _{CSSA68} t _{CSH68}	CS1/CS0	Chip select setup time			0 0	
$(1.65V \leq V_{DD})$	< 2.5V, Ta= -30) to +85°C)			(Read / Write)	
t _{AS68} t _{AH68}	CD	Address setup time Address hold time			0 0	_
t _{CY68}		System cycle time	16-bit bus 8-bit bus 4-bit bus		830 / 630 330 / 290 230 / 170	-
t _{PWR68}	WR1, WR0	High Pulse width	16-bit bus 8-bit bus 4-bit bus		400 / 300 150 / 130 100 / 70	-
t _{LPW68}	WR1, WR0	Low pulse width	16-bit bus 8-bit bus 4-bit bus		400 / 300 150 / 130 100 / 70	-
t _{DS68} t _{DH68}	D15~D0	Data setup time Data hold time			60 0	_
t _{ACC68} t _{OD68}		Read access time Output disable time		C _L = 100pF	– 50	120 -
t _{CSSA68} t _{CSH68}	CS1/CS0	Chip select setup time			0 0	

Note: The rising time and the falling time are stipulated to be equal to or less than 15nS.



High-Voltage Mixed-Signal IC

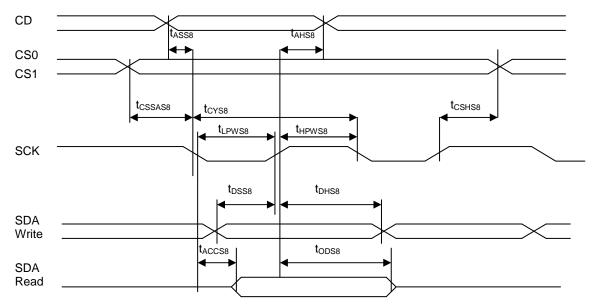


FIGURE 20: Serial Bus Timing Characteristics (for S8)

Symbol	Signal	Description	Condition	Min. (nS)	Max. (nS)
$(2.5V \leq V_{DD} <$	3.6V, Ta= −30 t	to +85°C)		(Read / Write)	
t _{ASS8} t _{AHS8}	CD	Address setup time Address hold time		0 0	_ _
t _{CYS8} t _{LPWS8} t _{HPWS8}	SCK	System cycle time Low pulse width High pulse width		150 / 51 60 / 18 60 / 18	- - -
t _{ACCS8} t _{ODS8}		Read access time Output disable time		- 15	50 -
t _{DSS8} t _{DHS8}	SDA	Data setup time Data hold time		15 0	_ _
t _{CSSAS8} t _{CSHS8}	CS1/CS0	Chip select setup time		0 / 0 0 / 0	
$(1.65V \leq V_{DD})$	< 2.5V, Ta= -30) to +85 [°] C)	(Read / Write)		
t _{ASS8} t _{AHS8}	CD	Address setup time Address hold time		0 0	_ _
t _{CYS8} t _{LPWS8} t _{HPWS8}	SCK	System cycle time Low pulse width High pulse width		270 / 110 120 / 30 120 / 30	
t _{ACCS8} t _{ODS8}		Read access time Output disable time		- 30	90 -
t _{DSS8} t _{DHS8}	SDA	Data setup time Data hold time		30 5	_
t _{CSSAS8} t _{CSHS8}	CS1/CS0	Chip select setup time		0 / 0 0 / 0	

Note: The rising time and the falling time are stipulated to be equal to or less than 15nS.

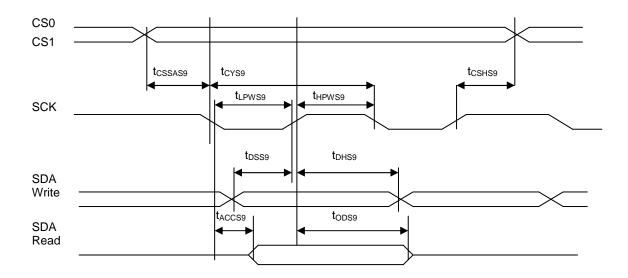


FIGURE 21: Serial Bus Timing Characteristics (for S9)

Symbol	Signal	Description	Condition	Min. (nS)	Max. (nS)
$(2.5V \leq V_{DD} <$	3.6V, Ta= -30	to +85 [°] C)		(Read / Write)	
t _{CYS9} t _{LPWS9} t _{HPWS9}	SCK	System cycle time Low pulse width High pulse width		150 / 51 60 / 18 60 / 18	_ _ _
t ACCS9 t ODS9	SDA	Read access time Output disable time		- 15	50 -
t _{DSS9} t _{DHS9}	SDA	Data setup time Data hold time		15 0	_
t _{CSSAS9} t _{CSHS9}	CS1/CS0	Chip select setup time		0/0 0/0	
$(1.65 \text{V} \leq \text{V}_{DD})$	< 2.5V, Ta= -30) to +85°C)	(Read / Write)		
tcys9 t _{LPWS9} t _{HPWS9}	SCK	System cycle time Low pulse width High pulse width		270 / 90 120 / 30 120 / 30	- - -
t _{ACCS9} t _{ODS9}	SDA	Read access time Output disable time		- 30	90 -
t _{DSS9} t _{DHS9}	SDA	Data setup time Data hold time		30 5	_
t _{CSSAS9} t _{CSHS9}	CS1/CS0	Chip select setup time		0 / 0 0 / 0	

Note: The rising time and the falling time are stipulated to be equal to or less than 15 nS.



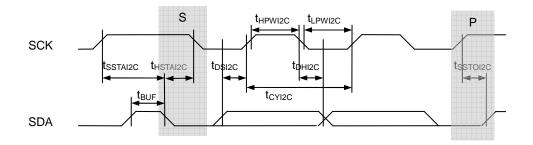


FIGURE 22: Serial bus timing characteristics (for I^2C)

Symbol	Signal	Description	Condition	Min. (nS)	Max. (nS)	
$(2.5V \leq V_{DD} <$	3.6V, Ta= -30 t	to +85°C)		(Read / Write)		
t _{CYI2C} t _{LPWI2C} t _{HPWI2C}	SCK	SCK cycle time Low pulse width High pulse width	tr+tf ≤ 100nS	610 / 306 290 / 138 290 / 138	ı	
tDSI2C tDHI2C tSSTAI2C tHSTAI2C tsSTOI2C	SCK	Data setup time Data hold time START Setup time START Hold time STOP setup time		33 11 28 50 28	1	
t _{BUF}	SDA	Bus Free time between STOP and START condition		165	-	
$(1.65V \leq V_{DD})$	< 2.5V, Ta= -30) to +85°C)	(Read / Write)			
t _{CYI2C} t _{LPWI2C} t _{HPWI2C}	SCK	SCK cycle time Low pulse width High pulse width	tr+tf ≤ 100nS	780 / 360 375 / 115 375 / 115	-	
t _{DSI2C} t _{DHI2C} t _{SSTAI2C} t _{HSTAI2C} t _{HSTAI2C} t _{SSTOI2C}	sck	Data setup time Data hold time START Setup time START Hold time STOP setup time		60 11 28 60 28	-	
t _{BUF}	SDA	Bus Free time between STOP and START condition		220	_	

Note: The rising time and the falling time are stipulated to be equal to or less than 15nS.

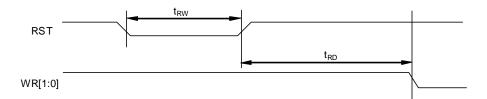


FIGURE 23: Reset Characteristics

Symbol	Signal	Description	Condition	Min.	Max.		
$(1.65 \text{V} \leq \text{V}_{DD})$	$(1.65 \text{V} \leq \text{V}_{DD} < 3.6 \text{V}, \text{Ta} = -30 \text{ to } +85^{\circ}\text{C})$						
t _{RW}	RST	Reset low pulse width		3 μS	_		
t _{RD}	RST, WR	Reset to WR pulse delay		10 mS	_		

Note:

For each mode, the signal's rising time and falling time (tf, tr) are stipulated to be equal to or less than 15nS.





PHYSICAL DIMENSIONS

High-Voltage Mixed-Signal IC

DIE INFORMATION

DIE SIZE:

13754 μ M x 1120 μ M \pm 40 μ M

DIE THICKNESS:

 $400~\mu M~\pm~20~\mu M$

BUMP HEIGHT:

 $15 \mu M \pm 3 \mu M$

 $(H_{MAX} - H_{MIN})$ within die $\leq 2\mu M$

BUMP PITCH:

38 µM (Typ.)

BUMP SIZE:

SEG/COM: $25 \times 75.5 \mu M^2$ (Typ.)

BUMP AREA:

1887.5 μM²

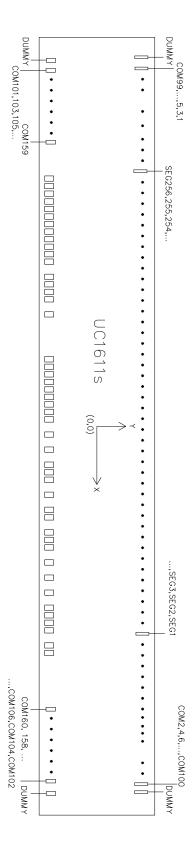
PAD COORDINATES:

Pad center

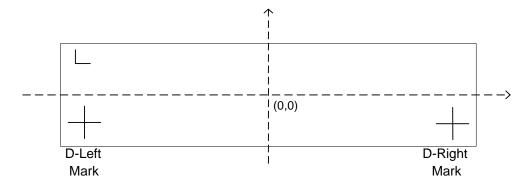
PAD ORIGIN:

Chip center

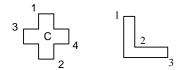
(Drawings and coordinates are in the circuit/bump view)



ALIGNMENT MARK INFORMATION



SHAPE OF THE ALIGNMENT MARK:



Note:

Alignment marks are on Metal3 under Passivation.

The "+" mark is symmetric both horizontally and vertically.

COORDINATES:

		Х	Υ	Х	Υ	
Mark	/ Point	Upper-Left	Mark (L)	Upper-Right Mark		
	1	-5160.4	394			
(L)	2	-5144.4	370			
	3	-5120.4	354			
		Down-Left Mark (+)		Down-Right Mark (+)		
	1	-5365.225	-453.5	5549	-453.5	
	2	-5345.225	-513.5	5569	-513.5	
(+)	3	-5385.225	-473.5	5529	-473.5	
	4	-5325.225	-493.5	5589	-493.5	
	С	-5355.225	-483.5	5559	-483.5	

TOP METAL AND PASSIVATION:





High-Voltage Mixed-Signal IC

PAD COORDINATES

#	Pad	Х	Υ	W	Н
1	DUMMY	-6785.5	-487.75	30	75.5
2	COM101	-6745	-487.75	25	75.5
3	COM103	-6707	-487.75	25	75.5
4	COM105	-6669	-487.75	25	75.5
5	COM107	-6631	-487.75	25	75.5
6	COM109	-6593	-487.75	25	75.5
7	COM111	-6555	-487.75	25	75.5
8	COM113	-6517	-487.75	25	75.5
9	COM115	-6479	-487.75	25	75.5
10	COM117	-6441	-487.75	25	75.5
11	COM119	-6403	-487.75	25	75.5
12	COM121	-6365	-487.75	25	75.5
13	COM123	-6327	-487.75	25	75.5
14	COM125	-6289	-487.75	25	75.5
15	COM127	-6251	-487.75	25	75.5
16	COM129	-6213	-487.75	25	75.5
17	COM131	-6175	-487.75	25	75.5
18	COM133	-6137	-487.75	25	75.5
19	COM135	-6099	-487.75	25	75.5
20	COM137	-6061	-487.75	25	75.5
21	COM139	-6023	-487.75	25	75.5
22	COM141	-5985	-487.75	25	75.5
23	COM143	-5947	-487.75	25	75.5
24	COM145	-5909	-487.75	25	75.5
25	COM147	-5871	-487.75	25	75.5
26	COM149	-5833	-487.75	25	75.5
27	COM151	-5795	-487.75	25	75.5
28	COM153	-5757	-487.75	25	75.5
29	COM155	-5719	-487.75	25	75.5
30	COM157	-5681	-487.75	25	75.5
31	COM159	-5643	-487.75	25	75.5
32	D15	-5227.975	-483.275	69.1	82.45
33	vdd	-5156.425	-483.275	25	82.45
34	D14	-5084.875	-483.275	69.1	82.45
35	D13	-4999.775	-483.275	69.1	82.45
36	D12	-4914.675	-483.275	69.1	82.45
37	D11	-4829.575	-483.275	69.1	82.45
38	D10	-4744.475		69.1	82.45
39	D9	-4659.375	-483.275	69.1	82.45
40	D8	-4574.275	-483.275	69.1	82.45
41	D7	-4489.175		69.1	82.45
42	D6	-4404.075		69.1	82.45
43	D5	-4318.975		69.1	82.45
44	D4	-4233.875	-483.275	69.1	82.45
45	D3	-4148.775	-483.275	69.1	82.45
46	D2	-4063.675	-483.275	69.1	82.45
47	D1	-3978.575	-483.275	69.1	82.45
48	D0	-3893.475		69.1	82.45
49	RST	-3786.925	-481	65	87
50	CS0	-3705.325	-481	65	87
51	vdd	-3625.525	-481	45	87

#	Pad	Х	Υ	W	Н
52	CS1	-3545.725	-481	65	87
53	CD	-3464.125	-481	65	87
54	WR0	-3382.525	-481	65	87
55	vdd	-3302.725	-481	45	87
56	WR1	-3222.925	-481	65	87
57	BM1	-3141.325	-481	65	87
58	vdd	-3061.525	-481	45	87
59	BM0	-2981.725	-481	65	87
60	TST4	-2901.925	-481	45	87
61	TST4	-2841.925	-481	45	87
62	ID0	-2554.125	-481	65	87
63	vdd	-2474.325	-481	45	87
64	ID1	-2394.525	-481	65	87
65	VSS	-2314.725	-481	45	87
66	VSS	-2254.725	-481	45	87
67	VSS	-2194.725	-481	45	87
68	VSS	-2134.725	-481	45	87
69	VSS	-2074.725	-481	45	87
70	VSS	-2014.725	-481	45	87
71	VSS	-1954.725	-481	45	87
72	VSS	-1894.725	-481	45	87
73	VSS	-1834.725	-481	45	87
74	VSS	-1774.725	-481	45	87
75	VSS	-1714.725	-481	45	87
76	vss2	-1541.725	-481	45	87
77	vss2	-1481.725	-481	45	87
78	vss2	-1421.725	-481	45	87
79	vss2	-1361.725	-481	45	87
80	vss2	-1301.725	-481	45	87
81	vss2	-1241.725	-481	45	87
82	vss2	-1181.725	-481	45	87
83	vss2	-1121.725	-481	45	87
84	vss2	-1061.725	-481	45	87
85	vss2	-1001.725	-481	45	87
86	vss2	-941.725	-481	45	87
87	vdd2	-881.725	-481	45	87
88	vdd2	-821.725	-481	45	87
89	vdd2	-761.725	-481	45	87
90	vdd2	-701.725	-481	45	87
91	vdd2	-641.725	-481	45	87
92	vdd2	-581.725	-481	45	87
93	vdd2	-521.725	-481	45	87
94	vdd2	-461.725	-481	45	87
95	vdd2	-401.725	-481	45	87
96	vdd2	-341.725	-481	45	87
97	DUMMY	-163.375	-481	45	87
98	vdd3	14.975	-481	45	87
99	vdd3	74.975	-481	45	87
100	vdd3	134.975	-481	45	87
101	vdd3	194.975	-481	45	87
102	vdd	254.975	-481	45	87

"		. v		147	
#	Pad	X	Y	W	H
103	vdd	314.975	-481	45	87
104	vdd	374.975	-481	45	87
105	vdd	434.975	-481	45	87
106	vdd	494.975	-481	45	87
107	vdd	554.975	-481	45	87
108	vdd	614.975	-481	45	87
109	vdd	674.975	-481	45	87
110	vdd	734.975	-481	45	87
111	vdd	794.975	-481	45	87
112	vdd	854.975	-481	45	87
113	DUMMY	1040.425	-481	45	87
114	DUMMY	1100.425	-481	45	87
115	DUMMY	1160.425	-481	45	87
116	DUMMY	1220.425	-481	45	87
117	DUMMY	1280.425	-481	45	87
118	DUMMY	1340.425	-481	45	87
119	DUMMY	1400.425	-481	45	87
120	DUMMY	1460.425	-481	45	87
121	TST2	1650.475	-481	45	87
122	TST1	1710.475	-481	45	87
123	VLCDIN	2050.35	-481	45	87
124	VLCDIN	2110.35	-481	45	87
125	VLCDOUT	2170.35	-481	45	87
126	VLCDOUT	2230.35	-481	45	87
127	VA0-	2642.35	-481	45	87
128	VA0-	2702.35	-481	45	87
129	VA0-	2762.35	-481	45	87
130	VA0-	2822.35	-481	45	87
131	VA1-	2882.35	-481	45	87
132	VA1-	2942.35	-481	45	87
133	VA1-	3002.35	-481	45	87
134	VA1-	3062.35	-481	45	87
135	VA1+	3402.35	-481	45	87
136	VA1+	3462.35	-481	45	87
137	VA1+	3522.35	-481	45	87
138	VA1+	3582.35	-481	45	87
139	VA0+	3642.35	-481	45	87
140	VA0+	3702.35	-481	45	87
141	VA0+	3762.35	-481	45	87
142	VA0+	3822.35	-481	45	87
143	VB0-	4162.35	-481	45	87
144	VB0-	4222.35	-481	45	87
145	VB0-	4282.35	-481	45	87
146	VB0-	4342.35	-481	45	87
147	VB1-	4402.35	-481	45	87
148	VB1-	4462.35	-481	45	87
149	VB1-	4522.35	-481	45	87
150	VB1-	4582.35	-481	45	87
151	VB1+	4922.35	-481	45	87
152	VB1+	4982.35	-481	45	87
153	VB1+	5042.35	-481	45	87
154	VB1+	5102.35	-481	45	87
155	VB0+	5162.35	-481	45	87
.00	V DO 1	0.102.00	701	70	01

#	Pad	Х	Υ	W	Н
156	VB0+	5222.35	-481	45	87
157	VB0+	5282.35	-481	45	87
158	VB0+	5342.35	-481	45	87
159	COM160	5643	-487.75	25	75.5
160	COM158	5681	-487.75	25	75.5
161	COM156	5719	-487.75	25	75.5
162	COM154	5757	-487.75	25	75.5
163	COM154	5795	-487.75	25	75.5
164	COM150	5833	-487.75	25	75.5
165	COM130	5871	-487.75	25	75.5
166	COM146	5909	-487.75	25	75.5
167	COM144	5947	-487.75	25	75.5
1					
168	COM142	5985	-487.75	25	75.5
169	COM140	6023	-487.75	25	75.5
170	COM138	6061	-487.75	25	75.5
171	COM136	6099	-487.75	25	75.5
172	COM134	6137	-487.75	25	75.5
173	COM132	6175	-487.75	25	75.5
174	COM130	6213	-487.75	25	75.5
175	COM128	6251	-487.75	25	75.5
176	COM126	6289	-487.75	25	75.5
177	COM124	6327	-487.75	25	75.5
178	COM122	6365	-487.75	25	75.5
179	COM120	6403	-487.75	25	75.5
180	COM118	6441	-487.75	25	75.5
181	COM116	6479	-487.75	25	75.5
182	COM114	6517	-487.75	25	75.5
183	COM112	6555	-487.75	25	75.5
184	COM110	6593	-487.75	25	75.5
185	COM108	6631	-487.75	25	75.5
186	COM106	6669	-487.75	25	75.5
187	COM104	6707	-487.75	25	75.5
188	COM102	6745	-487.75	25	75.5
189	DUMMY	6785.5	-487.75	30	75.5
190	DUMMY	6785.5	487.75	30	75.5
191	COM100	6745	487.75	25	75.5
192	COM98	6707	487.75	25	75.5
193	COM96	6669	487.75	25	75.5
194	COM94	6631	487.75	25	75.5
195	COM92	6593	487.75	25	75.5
196	COM90	6555	487.75	25	75.5
197	COM88	6517	487.75	25	75.5
198	COM86	6479	487.75	25	75.5
199	COM84	6441	487.75	25	75.5
200	COM82	6403	487.75	25	75.5
201	COM80	6365	487.75	25	75.5
202	COM78	6327	487.75	25	75.5
203	COM76	6289	487.75	25	75.5
204	COM74	6251	487.75	25	75.5
205	COM72	6213	487.75	25	75.5
206	COM70	6175	487.75	25	75.5
207	COM68	6137	487.75	25	75.5
208	COM66	6099	487.75	25	75.5



High-Voltage Mixed-Signal IC

#	Pad	Х	Υ	W	Н
			-		
209	COM64	6061	487.75	25	75.5
210	COM62	6023	487.75	25	75.5
211	COM60	5985	487.75	25	75.5
212	COM58	5947	487.75	25	75.5
213	COM56	5909	487.75	25	75.5
214	COM54	5871	487.75	25	75.5
215	COM52	5833	487.75	25	75.5
216	COM50	5795	487.75	25	75.5
217	COM48	5757	487.75	25	75.5
218	COM46	5719	487.75	25	75.5
219	COM44	5681	487.75	25	75.5
220	COM42	5643	487.75	25	75.5
221	COM40	5605	487.75	25	75.5
222	COM38	5567	487.75	25	75.5
223	COM36	5529	487.75	25	75.5
224	COM34	5491	487.75	25	75.5
225	COM32	5453	487.75	25	75.5
226	COM30	5415	487.75	25	75.5
227	COM28	5377	487.75	25	75.5
228	COM26	5339	487.75	25	75.5
229	COM24	5301	487.75	25	75.5
230	COM22	5263	487.75	25	75.5
231	COM20	5225	487.75	25	75.5
232	COM18	5187	487.75	25	75.5
233	COM16	5149	487.75	25	75.5
234	COM14	5111	487.75	25	75.5
235	COM12	5073	487.75	25	75.5
236	COM10	5035	487.75	25	75.5
237	COM8	4997	487.75	25	75.5
238	COM6	4959	487.75	25	75.5
239	COM4	4921	487.75	25	75.5
240	COM2	4883	487.75	25	75.5
241	SEG1	4845	487.75	25	75.5
242	SEG2	4807	487.75	25	75.5
243	SEG3	4769	487.75	25	75.5
244	SEG4	4731	487.75	25	75.5
245	SEG5	4693	487.75	25	75.5
246	SEG6	4655	487.75	25	75.5
247	SEG7	4617	487.75	25	75.5
248	SEG8	4579	487.75	25	75.5
249	SEG9	4541	487.75	25	75.5
250	SEG10	4503	487.75	25	75.5
251	SEG11	4465	487.75	25	75.5
252	SEG12	4427	487.75	25	75.5
253	SEG12	4389	487.75	25	75.5
254	SEG14	4351	487.75	25	75.5
254 255		4313	487.75		
	SEG15			25	75.5 75.5
256	SEG16	4275	487.75	25	75.5
257	SEG17	4237	487.75	25	75.5
258	SEG18	4199	487.75	25	75.5
259	SEG19	4161	487.75	25	75.5
260	SEG20	4123	487.75	25	75.5
261	SEG21	4085	487.75	25	75.5

262 SEG22 4047 487.75 25 75.5 263 SEG23 4009 487.75 25 75.5 264 SEG24 3971 487.75 25 75.5 265 SEG25 3933 487.75 25 75.5 266 SEG26 3895 487.75 25 75.5 268 SEG28 3819 487.75 25 75.5 268 SEG29 3781 487.75 25 75.5 269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3523 487.75 25 75.5 274 SEG36 3515 487.75 25 75.5 275 SEG37 3477	#	Pad	Х	Y	W	Н
263 SEG23 4009 487.75 25 75.5 264 SEG24 3971 487.75 25 75.5 265 SEG25 3933 487.75 25 75.5 266 SEG26 3895 487.75 25 75.5 267 SEG27 3857 487.75 25 75.5 268 SEG28 3819 487.75 25 75.5 268 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3553 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG33 3553 487.75 25 75.5 275 SEG36 33615						
264 SEG24 3971 487.75 25 75.5 265 SEG25 3933 487.75 25 75.5 266 SEG26 3895 487.75 25 75.5 267 SEG27 3857 487.75 25 75.5 268 SEG28 3819 487.75 25 75.5 269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 271 SEG32 3667 487.75 25 75.5 272 SEG33 3553 487.75 25 75.5 273 SEG34 3591 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 34339						
265 SEG25 3933 487.75 25 75.5 266 SEG26 3895 487.75 25 75.5 267 SEG27 3857 487.75 25 75.5 268 SEG28 3819 487.75 25 75.5 269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG33 3629 487.75 25 75.5 273 SEG34 3591 487.75 25 75.5 274 SEG36 3515 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439	264	SEG24				
266 SEG26 3895 487.75 25 75.5 267 SEG27 3857 487.75 25 75.5 268 SEG28 3819 487.75 25 75.5 269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 281 SEG41 3325						
267 SEG27 3857 487.75 25 75.5 268 SEG28 3819 487.75 25 75.5 269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 278 SEG39 3401 487.75 25 75.5 281 SEG41 3325						
268 SEG28 3819 487.75 25 75.5 269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287						
269 SEG29 3781 487.75 25 75.5 270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3227 487.75 25 75.5 282 SEG42 3287						
270 SEG30 3743 487.75 25 75.5 271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG36 3553 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3211	-					
271 SEG31 3705 487.75 25 75.5 272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG36 3515 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211						-
272 SEG32 3667 487.75 25 75.5 273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG35 3553 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173	-					
273 SEG33 3629 487.75 25 75.5 274 SEG34 3591 487.75 25 75.5 275 SEG35 3553 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 284 SEG45 3173 487.75 25 75.5 285 SEG46 3135						
274 SEG34 3591 487.75 25 75.5 275 SEG35 3553 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097						
275 SEG35 3553 487.75 25 75.5 276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059						
276 SEG36 3515 487.75 25 75.5 277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG50 2983						
277 SEG37 3477 487.75 25 75.5 278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 288 SEG49 3021 487.75 25 75.5 289 SEG50 2983						
278 SEG38 3439 487.75 25 75.5 279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945	_					
279 SEG39 3401 487.75 25 75.5 280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907	-					_
280 SEG40 3363 487.75 25 75.5 281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 289 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869	-					_
281 SEG41 3325 487.75 25 75.5 282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 288 SEG49 3021 487.75 25 75.5 289 SEG50 2983 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869						
282 SEG42 3287 487.75 25 75.5 283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 289 SEG50 2983 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 294 SEG54 2831	-					
283 SEG43 3249 487.75 25 75.5 284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 293 SEG54 2831 487.75 25 75.5 295 SEG55 2793						
284 SEG44 3211 487.75 25 75.5 285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 290 SEG51 2945 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 293 SEG54 2831 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793	-					
285 SEG45 3173 487.75 25 75.5 286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717	-					
286 SEG46 3135 487.75 25 75.5 287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 293 SEG54 2831 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG56 2755 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679						
287 SEG47 3097 487.75 25 75.5 288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 293 SEG54 2831 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 300 SEG61 2565						
288 SEG48 3059 487.75 25 75.5 289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 301 SEG61 2565						
289 SEG49 3021 487.75 25 75.5 290 SEG50 2983 487.75 25 75.5 291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527						
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291 SEG51 2945 487.75 25 75.5 292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 298 SEG59 2641 487.75 25 75.5 299 SEG60 2603 487.75 25 75.5 300 SEG61 2565 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489						
292 SEG52 2907 487.75 25 75.5 293 SEG53 2869 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413						_
293 SEG53 2869 487.75 25 75.5 294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 307 SEG66 2375						
294 SEG54 2831 487.75 25 75.5 295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337						
295 SEG55 2793 487.75 25 75.5 296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299	-					
296 SEG56 2755 487.75 25 75.5 297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261						
297 SEG57 2717 487.75 25 75.5 298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223						
298 SEG58 2679 487.75 25 75.5 299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185						
299 SEG59 2641 487.75 25 75.5 300 SEG60 2603 487.75 25 75.5 301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147	_					
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301 SEG61 2565 487.75 25 75.5 302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5						
302 SEG62 2527 487.75 25 75.5 303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5						
303 SEG63 2489 487.75 25 75.5 304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5						-
304 SEG64 2451 487.75 25 75.5 305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5						
305 SEG65 2413 487.75 25 75.5 306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5	-					
306 SEG66 2375 487.75 25 75.5 307 SEG67 2337 487.75 25 75.5 308 SEG68 2299 487.75 25 75.5 309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5						
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309 SEG69 2261 487.75 25 75.5 310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5						
310 SEG70 2223 487.75 25 75.5 311 SEG71 2185 487.75 25 75.5 312 SEG72 2147 487.75 25 75.5 313 SEG73 2109 487.75 25 75.5	-					_
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313 SEG73 2109 487.75 25 75.5	-					
	-					
	314	SEG74	2071	487.75	25	75.5

#	Pad	Х	Υ	W	Н
315	SEG75	2033	487.75	25	75.5
316	SEG76	1995	487.75	25	75.5
317	SEG77	1957	487.75	25	75.5
318	SEG78	1919	487.75	25	75.5
319	SEG79	1881	487.75	25	75.5
320	SEG80	1843	487.75	25	75.5
321	SEG81	1805	487.75	25	75.5
322	SEG82	1767		25	75.5
323	SEG83	1707	487.75	25	75.5
324	SEG84	1691	487.75 487.75	25	75.5
-		1653			
325	SEG85		487.75	25	75.5
326	SEG86	1615	487.75	25	75.5
327	SEG87	1577	487.75	25 25	75.5
328	SEG88	1539	487.75		75.5
329	SEG89	1501	487.75	25	75.5
330	SEG90	1463	487.75	25	75.5
331	SEG91	1425	487.75	25	75.5
332	SEG92	1387	487.75	25	75.5
333	SEG93	1349	487.75	25	75.5
334	SEG94	1311	487.75	25	75.5
335	SEG95	1273	487.75	25	75.5
336	SEG96	1235	487.75	25	75.5
337	SEG97	1197	487.75	25	75.5
338	SEG98	1159	487.75	25	75.5
339	SEG99	1121	487.75	25	75.5
340	SEG100	1083	487.75	25	75.5
341	SEG101	1045	487.75	25	75.5
342	SEG102	1007	487.75	25	75.5
343	SEG103	969	487.75	25	75.5
344	SEG104	931	487.75	25	75.5
345	SEG105	893	487.75	25	75.5
346	SEG106	855	487.75	25	75.5
347	SEG107	817	487.75	25	75.5
348	SEG108	779	487.75	25	75.5
349	SEG109	741	487.75	25	75.5
350	SEG110	703	487.75	25	75.5
351	SEG111	665	487.75	25	75.5
352	SEG112	627	487.75	25	75.5
353	SEG113	589	487.75	25	75.5
354	SEG114	551	487.75	25	75.5
355	SEG115	513	487.75	25	75.5
356	SEG116	475	487.75	25	75.5
357	SEG117	437	487.75	25	75.5
358	SEG118	399	487.75	25	75.5
359	SEG119	361	487.75	25	75.5
360	SEG120	323	487.75	25	75.5
361	SEG121	285	487.75	25	75.5
362	SEG122	247	487.75	25	75.5
363	SEG123	209	487.75	25	75.5
364	SEG124	171	487.75	25	75.5
365	SEG125	133	487.75	25	75.5
366	SEG126	95	487.75	25	75.5
367	SEG127	57	487.75	25	75.5

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#	Pad	X 10	Y	W	75.5
368	SEG128	19	487.75	25	75.5
369	SEG129	-19	487.75	25	75.5
370	SEG130	-57	487.75	25	75.5
371	SEG131	-95	487.75	25	75.5
372	SEG132	-133	487.75	25	75.5
373	SEG133	-171	487.75	25	75.5
374	SEG134	-209	487.75	25	75.5
375	SEG135	-247	487.75	25	75.5
376	SEG136	-285	487.75	25	75.5
377	SEG137	-323	487.75	25	75.5
378	SEG138	-361	487.75	25	75.5
379	SEG139	-399	487.75	25	75.5
380	SEG140	-437	487.75	25	75.5
381	SEG141	-475	487.75	25	75.5
382	SEG142	-513	487.75	25	75.5
383	SEG143	-551	487.75	25	75.5
384	SEG144	-589	487.75	25	75.5
385	SEG145	-627	487.75	25	75.5
386	SEG146	-665	487.75	25	75.5
387	SEG147	-703	487.75	25	75.5
388	SEG148	-741	487.75	25	75.5
389	SEG149	-779	487.75	25	75.5
390	SEG150	-817	487.75	25	75.5
391	SEG151	-855	487.75	25	75.5
392	SEG152	-893	487.75	25	75.5
393	SEG153	-931	487.75	25	75.5
394	SEG154	-969	487.75	25	75.5
395	SEG155	-1007	487.75	25	75.5
396	SEG156	-1045	487.75	25	75.5
397	SEG157	-1083	487.75	25	75.5
398	SEG158	-1121	487.75	25	75.5
399	SEG159	-1159	487.75	25	75.5
400	SEG160	-1197	487.75	25	75.5
401	SEG161	-1235	487.75	25	75.5
402	SEG162	-1273	487.75	25	75.5
403	SEG163	-1311	487.75	25	75.5
404	SEG164	-1349	487.75	25	75.5
405	SEG165	-1387	487.75	25	75.5
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408	SEG168	-1501	487.75	25	75.5
409	SEG169	-1539	487.75	25	75.5
410	SEG170	-1577	487.75	25	75.5
411	SEG171	-1615	487.75	25	75.5
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413	SEG173	-1691	487.75	25	75.5
414	SEG174	-1729	487.75	25	75.5
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416	SEG176	-1805	487.75	25	75.5
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418	SEG178	-1881	487.75	25	75.5
419	SEG179	-1919	487.75	25	75.5
420	SEG180	-1957	487.75	25	75.5
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#	Pad	X	Υ	W	H
421	SEG181	-1995	487.75	25	75.5
422	SEG182	-2033	487.75	25	75.5
423	SEG183	-2071	487.75	25	75.5
424	SEG184	-2109	487.75	25	75.5
425	SEG185	-2147	487.75	25	75.5
426	SEG186	-2185	487.75	25	75.5
427	SEG187	-2223	487.75	25	75.5
428	SEG188	-2261	487.75	25	75.5
429	SEG189	-2299	487.75	25	75.5
430	SEG190	-2337	487.75	25	75.5
431	SEG191	-2375	487.75	25	75.5
432	SEG192	-2413	487.75	25	75.5
433	SEG193	-2451	487.75	25	75.5
434	SEG194	-2489	487.75	25	75.5
435	SEG195	-2527	487.75	25	75.5
436	SEG196	-2565	487.75	25	75.5
437	SEG197	-2603	487.75	25	75.5
438	SEG198	-2641	487.75	25	75.5
439	SEG199	-2679	487.75	25	75.5
440	SEG200	-2717	487.75	25	75.5
441	SEG201	-2755	487.75	25	75.5
442	SEG202	-2793	487.75	25	75.5
443	SEG203	-2831	487.75	25	75.5
444	SEG204	-2869	487.75	25	75.5
445	SEG205	-2907	487.75	25	75.5
446	SEG206	-2945	487.75	25	75.5
447	SEG207	-2983	487.75	25	75.5
448	SEG208	-3021	487.75	25	75.5
449	SEG209	-3059	487.75	25	75.5
450	SEG210	-3097	487.75	25	75.5
451	SEG211	-3135	487.75	25	75.5
452	SEG212	-3173	487.75	25	75.5
453	SEG213	-3211	487.75	25	75.5
454	SEG214	-3249	487.75	25	75.5
455	SEG215	-3287	487.75	25	75.5
456	SEG216	-3325	487.75	25	75.5
457	SEG217	-3363	487.75	25	75.5
458	SEG218	-3401	487.75	25	75.5
459	SEG219	-3439	487.75	25	75.5
460	SEG220	-3477	487.75	25	75.5
461	SEG221	-3515	487.75	25	75.5
462	SEG222	-3553	487.75	25	75.5
463	SEG223	-3591	487.75	25	75.5
464	SEG224	-3629	487.75	25	75.5
465	SEG225	-3667	487.75	25	75.5
466	SEG226	-3705	487.75	25	75.5
467	SEG227	-3743	487.75	25	75.5
468	SEG228	-3781	487.75	25	75.5
469	SEG229	-3819	487.75	25	75.5
470	SEG230	-3857	487.75	25	75.5
471	SEG231	-3895	487.75	25	75.5
472	SEG232	-3933	487.75	25	75.5
473	SEG233	-3971	487.75	25	75.5
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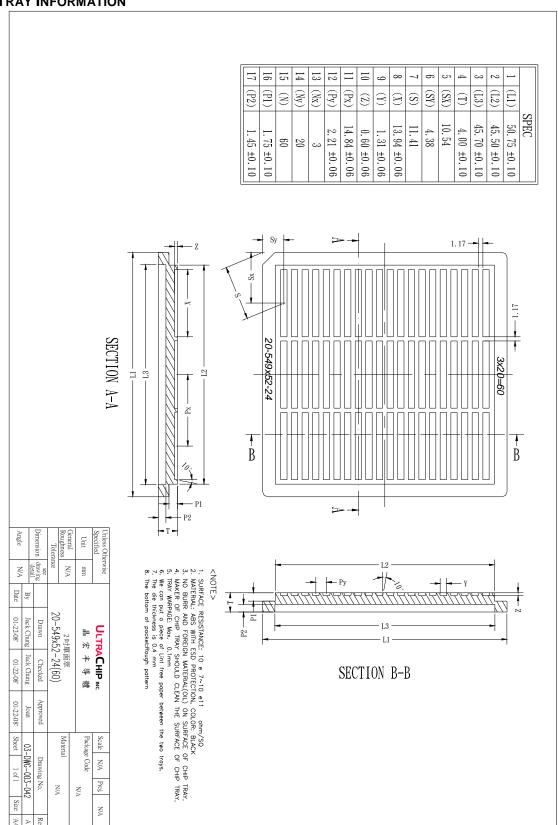
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474	SEG234	-4009	487.75	25	75.5
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477	SEG237	-4123	487.75	25	75.5
478	SEG238	-4161	487.75	25	75.5
479	SEG239	-4199	487.75	25	75.5
480	SEG240	-4237	487.75	25	75.5
481	SEG241	-4275	487.75	25	75.5
482	SEG242	-4313	487.75	25	75.5
483	SEG243	-4351	487.75	25	75.5
484	SEG244	-4389	487.75	25	75.5
485	SEG245	-4427	487.75	25	75.5
486	SEG246	-4465	487.75	25	75.5
487	SEG247	-4503	487.75	25	75.5
488	SEG248	-4541	487.75	25	75.5
489	SEG249	-4579	487.75	25	75.5
490	SEG250	-4617	487.75	25	75.5
491	SEG251	-4655	487.75	25	75.5
492	SEG252	-4693	487.75	25	75.5
493	SEG253	-4731	487.75	25	75.5
494	SEG254	-4769	487.75	25	75.5
495	SEG255	-4807	487.75	25	75.5
496	SEG256	-4845	487.75	25	75.5
497	COM1	-4883	487.75	25	75.5
498	COM3	-4921	487.75	25	75.5
499	COM5	-4959	487.75	25	75.5
500	COM7	-4997	487.75	25	75.5
501	COM9	-5035	487.75	25	75.5
502	COM11	-5073	487.75	25	75.5
503 504	COM13 COM15	-5111 -5149	487.75	25	75.5
505	COM17	-5149	487.75 487.75	25 25	75.5 75.5
506	COM17	-5225	487.75	25	75.5
507	COM19 COM21	-5263	487.75	25	75.5
508	COM21	-5203	487.75	25	75.5
509	COM25			25	75.5
510		-5339 -5377	487.75		75.5
511	COM27 COM29	-5415	487.75	25 25	75.5
			487.75		
512	COM31	-5453	487.75	25	75.5
513	COM33	-5491	487.75	25	75.5
514	COM35	-5529	487.75	25	75.5
515	COM37 COM39	-5567	487.75	25	75.5
516		-5605	487.75	25	75.5
517	COM41	-5643	487.75	25	75.5
518	COM43	-5681	487.75	25	75.5
519	COM45	-5719 -5757	487.75	25	75.5
520	COM47	-5757	487.75	25	75.5
521	COM49	-5795	487.75	25	75.5
522	COM51	-5833	487.75	25	75.5
523	COM53	-5871	487.75	25	75.5
524	COM55	-5909	487.75	25	75.5
525	COM57	-5947	487.75	25	75.5
526	COM59	-5985	487.75	25	75.5

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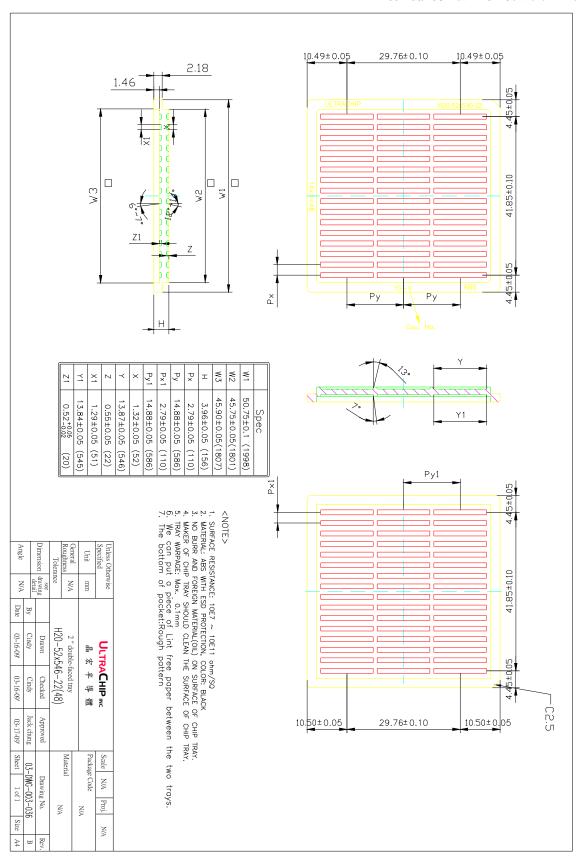
#	Pad	Х	Y	W	Н
527	COM61	-6023	487.75	25	75.5
528	COM63	-6061	487.75	25	75.5
529	COM65	-6099	487.75	25	75.5
530	COM67	-6137	487.75	25	75.5
531	COM69	-6175	487.75	25	75.5
532	COM71	-6213	487.75	25	75.5
533	COM73	-6251	487.75	25	75.5
534	COM75	-6289	487.75	25	75.5
535	COM77	-6327	487.75	25	75.5
536	COM79	-6365	487.75	25	75.5
537	COM81	-6403	487.75	25	75.5
538	COM83	-6441	487.75	25	75.5
539	COM85	-6479	487.75	25	75.5
540	COM87	-6517	487.75	25	75.5
541	COM89	-6555	487.75	25	75.5
542	COM91	-6593	487.75	25	75.5
543	COM93	-6631	487.75	25	75.5
544	COM95	-6669	487.75	25	75.5
545	COM97	-6707	487.75	25	75.5
546	COM99	-6745	487.75	25	75.5
547	DUMMY	-6785.5	487.75	30	75.5

High-Voltage Mixed-Signal IC

TRAY INFORMATION



160x256/16S Matrix LCD Controller-Driver



High-Voltage Mixed-Signal IC

REVISION HISTORY

Revision	Contents			
0.6	First-time release	Apr. 28, '08		
1.0	 (1) The relationship between V_{DD} and V_{DD2/3} is adjusted to make V_{DD2/3} between V_{DD} ~ V_{DD}+1.5V (Section "Pin Description" – V_{DD} V_{DD2} V_{DD3}, p. 6) (2) The description of connection of capacitors is updated. (Section "Pin Description" – C_{AX}/C_{BX}, p. 6) (3) The recommended C_B value is adjusted: 100~150 times → 100~250 times of (Section "Pin Description" – Notes, p. 6; "Hi-V Generator and Bias Reference Circuit", p. 30) (4) The formula of Mux-rate is updated to DEN-DST+1+LC[3] x FL x 2 (Section "Control Registers" – LC, p. 12; "Command Description" – (14), p. 19; "Command Description" – (30), p. 24) (5) The description of LC[3] is updated. (Section "Command Description" – (21), p. 22) (6) The description of the command is updated. (Section "Command Description" – (9), p. 18) (7) The V_{LCD} chart and the table are updated. (Section "V_{LCD} Quick Reference", p. 29) (8) Figures 4a and 5a illustrating Read in S8 and S9 modes are inserted. (Section "Host Interfaces", p. p. 36–37) (9) The description on Sleep Mode and Draining Circuit is updated. (Section "Reset and Power Management", p. 49) (10) The description of Power-Down Sequence is updated. (Section "Reset & Power Management", p. 50) (11) The settings of MTP2/3 for MTP Read/Program/Erase are updated: for Program/Erase, MTP3: 28h → 25h for Read, MTP2: 6Fh → 69h (Section "MTP Operation for LCM Makers", p. 51; "MTP Command Sequence Sample Codes", Pp. 54–55) (12) V_{DD2/3} · V_{DD} (Max.) is adjusted: 1.2 → 2.0V (Section "Absolute Maximum Ratings", p. 58) (13) Input logic Low, V_{IL} (Max.), is adjusted: 0.15 → 0.2 times of V_{DD} Input logic High, V_H (Min.), is adjusted: 0.5 → 0.8 times of V_{DD} SEG output impedance, R_{0(COM)} (Typ.), is adjusted: 1.2 → 1.35 kΩ (Section "Specifications" – Doc Characteristics, p. 59) (14) Power consumption data (maximum) present. (Section "Specifications" – Power Consumption, p. 59) <	Jun. 11, '08		
1.1	 (Section "AC Characteristics", Pp 60~66) (1) C_A is added to the Note description. (Section "Pin Description", p 6; "Hi-V Generator & Bias Reference Circuit", p 30) (2) The example under the RAM table is corrected. (Section "Display Data RAM", p 48) 			
1.2	(1) The Y coordinates of pins 1 to 31 are corrected: -487.5 → -487.75 (Section "Pad Coordinates", p 70)	Sep. 4, '08		
1.3	(1) The COG drawing is updated. (Section "Recommended COG Layout", p 10)	Dec. 15, '08		

UC1611s

160x256/16S Matrix LCD Controller-Driver

Revision	Contents	Date		
1.31	 (1) Number of bits of MTPC: 5 → 6 (Section "Control Register", p 13) (2) Some MTP names are corrected: MTP3 → MTP2, MTP2 → MTP1, MTP4 → MTP3, MTP5 → MTP4 (Section "MTP OPERATION FOR LCM MAKERS", Pp 52~55) 			
1.4	(1) One more tray drawing is added. (Section "Tray Information", p 75)	Mar. 19, '09		
1.41	 The number of bits is corrected to include D6. (Section "Command Table" - (32)(34), p 15; "Command Description", p 25) The command name is corrected: Column → Row (Section "Command Table" - (34), p 15) The numbering of SEGs in the RAM table is corrected. (Section "Display Data RAM", Pp 47~48) The command code for PMO is corrected. D6: 1 → 0 (Section "MTP Operation for LCM Makers" - Table "MTP Erase Sample Code", p 55) A note on rising edge and falling edge is added. (Section "AC Characteristics", p 65) The Passivation drawing is updated. (Section "Alignment Mark Information", p 67) 	Jun. 10, '09		
1.42	(1) A legacy error is corrected: row address → page address.(overall)			
1.43	 Cycle times are adjusted by adding rising time and falling time. (Section "AC Characteristics", Pp 58~63) 	Jul. 3, '09		